SOLOMON SYSTECH SEMICONDUCTOR TECHNICAL DATA



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SSD1325

Advance Information

128 x 80, 16 Gray Scale Dot Matrix OLED/PLED Segment/Common Driver with Controller

This document contains information on a new product. Specifications and information herein are subject to change without notice.



Appendix: IC Revision history of SSD1325 Specification

Version	Change Items	Effective Date
1.0	 Changed to Advance Info Added information of SSD1325T3R1 and SSD1325UR1 Revised the cutline tolerance of SSD1325T3R1 and SSD1325UR1 	11-Aug-04
1.1	Added information of SSD1325U2	03-Jan-05
1.2	Added information of SSD1325T1R1 and SSD1325T6R1	03-Oct-05
1.3	 Added application example of SSD1325T1R1 Revised commands B1h, B3h, BCh, BEh Revised command descriptions: "Set Row Period" and "Set Display Clock Divide Ratio" Revised SSD1325U2 pin assignment Corrected the SCLK(D0) waveform in the figure of Serial Interface Characteristic: Original: SCLK(DA) Now: 	06-Feb-06
1.4	 Added Graphic Acceleration Commands (23h, 24h, 25h, 26h, 2Eh, 2Fh) Revised commands AEh, AFh, B8h in command table Revise SSD1325 die drawing and pad coordinate Added a note on capacitor value on application example Added a note in B1 command (0 DCLK is invalid in Phase 1&2) Revised D/C#, CL pin description Revised MCU interface section 	04-Sep-06
1.5	 Added power on / off sequence Add RESET timing in the AC Characteristics Table 	05-Oct-06
1.6	 Revised hex code of AEh in command table Revised the figure of Segment Current vs Contrast Setting Revised command description of Set Contrast Control Register 	24-Oct-06
1.7	Added commands B0h and B4h on the command table Added note in command ADh (Set Master Configuration) in command table	03-Jul-07
1.8	 Revised pin description of VSL and VSLCAP pin Removed SSD1325UR1, SSD1325T3R1, SSD1325U2 and SSD1325T1R1 dwgs Revised application example from SSD1325T1R1 to SSD1325T6R1 Added light sensitivity note under Table 22 - Maximum Ratings Added commands BFh in command table, VSL pin description & application example 	08-Aug-07
1.9	 Added a Remark column in the Ordering Information table Removed the internal DC-DC block from the SSD1325 Block Diagram Amended the die size Updated the Pin Description table and added pin descriptions for FR and DOF# 	16-Oct-07

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Version	Change Items	Effective Date
	 Removed the internal DC-DC voltage converter and its corresponding information Added details on section 8.2 (Segment drivers / Common drivers) Added details on section 8.6 (Current Control and Voltage Control) Revised sections 10.1.6 (Set Display Start Line (A1h)) & 10.1.7 (Set Display Offset (A2h)) by adding examples Revised section 10.1.10 (Set Master Configuration (ADh)) Added Remark on section 15.1 SSD1325Z Die Tray Information Added application example of SSD1325Z SPI serial interface Revise the adjacent pin uniformity limit to +/-1.5% 	
2.0	Amended the die size Revised the die tray information	19-Dec-07
2.1	 Revised the default values of commands BCh and BEh in command table Removed the below figures: Figure 30: VCOMH vs Bit Value Figure 31: VP vs Bit Value Added and revised Power on / off Sequence notes (2~5) 	15-May-08
2.2	Deleted the statement "OLED driving output voltage, 14V maximum" in the Features list (section 2)	11-Aug-08
2.3	 Replace SSD1325Z by SSD1325Z2 and add SSD1325Z2 into section 3 ordering information (P.8) Revise die thickness tolerance from ±25um to ±15um in section 5 (P.10) Added +/- 50um tolerance for Die Size section 5 (P.10) Revise typo in AEh / AFh command (P.33) Revise typo in B3h command (p.34) Revise disclaimer (P.63) 	13-Jul-10

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1 GENERAL DESCRIPTION

SSD1325 is a single-chip CMOS OLED/PLED driver with controller for organic/polymer light emitting diode dot-matrix graphic display system. It consists of 208 high voltage/current driving output pins for driving 128 segments and 80 commons. This IC is designed for Common Cathode type OLED/PLED panel.

SSD1325 displays data directly from its internal 128x80x4 bits Graphic Display Data RAM (GDDRAM). Data/Commands are sent from general MCU through the hardware selectable 6800-/8080-series compatible Parallel Interface or Serial Peripheral Interface.

It has a 128-step contrast control and a 16 gray level control. The embedded on-chip oscillator and DC-DC voltage converter reduce the number of external components.

2 FEATURES

- Support max. 128 x 80 matrix panel
- Power supply: $V_{DD} = 2.4V 3.5V$

$$V_{CC} = 8.0V - 16.0V$$

- For matrix display:
 - o Can output maximum segment source current: 300uA
 - o Common maximum sink current: 40mA
- Embedded 128 x 80 x 4 bit SRAM display memory
- 128 step contrast current control on monochrome passive OLED panel
- 16 gray scale
- Internal Oscillator
- Programmable Frame Rate
- 8-bit 6800-series Parallel Interface, 8080-series Parallel Interface, Serial Peripheral Interface.
- Row re-mapping and Column re-mapping
- Low power consumption (<5.0uA @sleep mode)
- Wide range of operating temperature: -40 to 85 °C

3 ORDERING INFORMATION

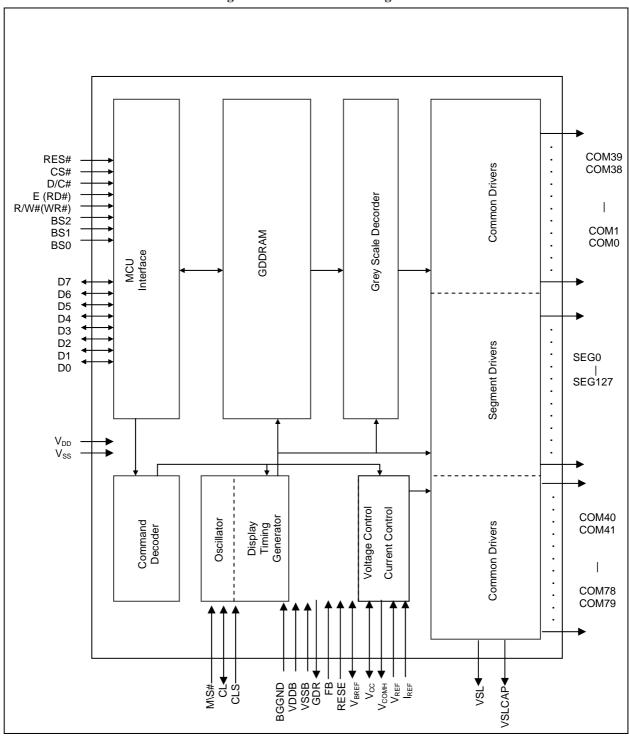
Table 1: Ordering Information

Ordering Part Number	SEG	СОМ	Package Form	Reference	Remarks
SSD1325Z2	128	80	COG	Page 10, 59	Min SEG pad pitch: 52.2umMin COM pad pitch: 51.8um
SSD1325T6R1	128	80	ТАВ	Page 60	 8-bit 80 / 68 / SPI interface Output lead pitch: 0.12mm x 0.998 = 0.11976mm 4 SPH, 35m film Full resolution 128 x 80

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4 BLOCK DIAGRAM

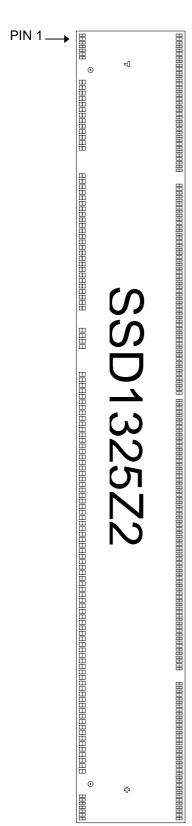
Figure 1: SSD1325 Block Diagram



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5 DIE PAD FLOOR PLAN

Figure 2: SSD1325Z2 Die Drawing





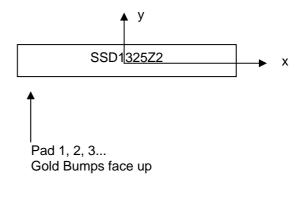
Note

1+ represents the centre of the alignment mark

Alignment Mark	X-pos (μm)	Y-pos (μm)
o Shape	4934.100	-557.675
	-4934.100	-557.675
+ shape	5014.100	-52.200
T shape	-5014.100	-52.200

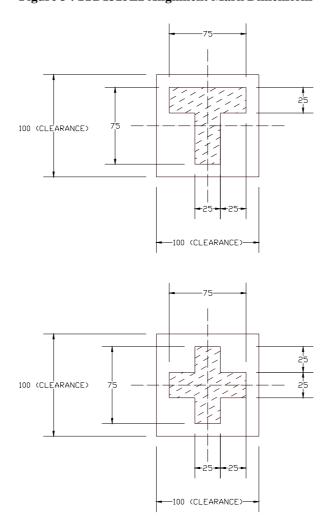
Die Size	10942um +/- 50um x 1508um +/- 50um
Die Thickness	457 +/- 15um
I/O pad pitch	76.2um
SEG pad pitch	52.2um
COM pad pitch	51.8um
Bump Height	Nominal 12um

Bump size	X (um)	Y (um)
Pad 1-7,123-331	34	84
Pad 8-122	54	84



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Figure 3: SSD1325Z2 Alignment Mark Dimensions



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Table 2 : SSD1325Z2 Bump Die Pad Coordinates

Pad#	- ·		
1	Signal DUMMY	X-pos -5414.000	Y-pos -672.075
2	DUMMY	-5361.800	-672.075
3	COM75	-5309.600	-672.075
4	COM76	-5257.800	-672.075
5	COM77	-5206.000	-672.075
6	COM78	-5154.200	-672.075
7	COM79	-5102.400	-672.075
8	DUMMY	-4767.075	-672.075
9	DUMMY	-4690.875	-672.075
10	DUMMY	-4614.675	-672.075
11	DUMMY	-4538.475	-672.075
12	DUMMY	-4462.275	-672.075
13	DUMMY	-4386.075	-672.075
14	DUMMY	-4309.875	-672.075
15	DUMMY	-4233.675	-672.075
16	DUMMY	-4157.475	-672.075
17	DUMMY	-4081.275	-672.075
18 19	DUMMY	-4005.075 -3928.875	-672.075
20	DUMMY	-3928.875	-672.075 -672.075
21	VCL	-3471.675	-672.075
22	VCL	-3395.475	-672.075
23	VCL	-3395.475	-672.075
23	VSS		
25	VSSB	-3243.075 -3166.875	-672.075
		-3166.875	-672.075
26	VSSB VSL	-3090.675	-672.075
27 28	VSLCAP	-3014.475 -2938.275	-672.075 -672.075
28	VSLCAP	-2938.275	-672.075
30	VSLCAP	-2862.075	-672.075
31	VCC	-2709.675	-672.075
32	VCC	-2633.475	-672.075
33	VCOMH	-2557.275	-672.075
34	VCOMH	-2481.075	-672.075
35	TR8	-2404.875	-672.075
36	TR7	-2328.675	-672.075
37	TR6	-2252.475	-672.075
38	TR5	-2176.275	-672.075
39	TR4	-2100.075	-672.075
40	TR3	-2023.875	-672.075
41	TR2	-1947.675	-672.075
42	TR1	-1871.475	-672.075
43	TR0	-1795.275	-672.075
44	VSS	-1719.075	-672.075
45	VSSB	-1642.875	-672.075
46	GDR	-1338.075	-672.075
47	GDR	-1261.875	-672.075
48	GDR	-1185.675	-672.075
49	GDR	-1109.475	-672.075
50	V DDB	-728.475	-672.075
51	VDDB	-652.275	-672.075
52	VDD	-576.075	-672.075
53	VDD	-499.875	-672.075
54	FB	-423.675	-672.075
55	RESE	-347.475	-672.075
56	RESE VBREF	-271.275	-672.075 -672.075
56 57	RESE VBREF BGGND	-271.275 -195.075	-672.075 -672.075 -672.075
56 57 58	RESE VBREF BGGND VSS	-271.275 -195.075 -118.875	-672.075 -672.075 -672.075
56 57 58 59	RESE VBREF BGGND VSS VCC	-271.275 -195.075 -118.875 -42.675	-672.075 -672.075 -672.075 -672.075
56 57 58 59 60	RESE VBREF BGGND VSS VCC GPIO0	-271.275 -195.075 -118.875 -42.675 33.525	-672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61	RESE VBREF BGGND VSS VCC GPIO0 GPIO1	-271.275 -195.075 -118.875 -42.675 33.525 109.725	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64	RESE VBREF BGGND VSS VCC GPI00 GPI01 VDD BS0 VSS	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VSD BS0 VSS BS1	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65	RESE VBREF BGGND VSS GPIO0 GPIO1 VDD BS0 VSS BS1 VDD	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525 490.725 666.925 643.125	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF#	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68 69 70	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325 795.525	672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73	RESE VBRET BGGND VSS VCC GPI001 GPI001 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS#	-271.275 -195.075 -118.875 -42.675 33.525 109.725 185.925 262.125 338.325 414.525 490.725 66.925 643.125 719.325 795.525 871.725	-672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73	RESE VBREF BGGNID VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# RES#	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 947.925 1024.125	672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68 70 71 72 73 74	RESE VBREF BGGNID VSS VCC GPIOI GPIOI VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOFF RESE CS# RES# RES# CS# CS# CS# CS# CS# CS# CS# CS# CS# C	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 947.925 1024.125 1100.325	672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73 74 75	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS RES# DIC# VSS	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325 795.525 871.725 947.925 1024.125 1100.325 1176.525	672.075 672.075
56 57 58 59 60 61 62 63 64 65 66 67 70 71 72 73 74 75 76	RESE VBRET BGGND VSS GPIO0 GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# PC# VSS RW#(WR#)	-271.275 -195.075 -118.875 -42.675 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 947.925 1024.125 1176.525 1176.525 1252.725 1328.925	672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73 74 75 76 77	RESE VBREF BGGND VSS VCC GHOO GPIOI VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# RES# DIC# VSS ZW#(WRF)	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 1024.125 1100.325 1176.525 1252.725 1328.925	672.075 672.075
56 57 58 59 60 61 62 63 64 65 66 67 70 71 72 73 74 75 76 77	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# RES# DIC# VSS RW#(WR#) E(RD#) VDD	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325 795.525 871.725 947.925 1024.125 1176.525	672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 68 70 71 72 73 74 75 76 77 78 80	RESE VBRET BGGND VSS VCC GPIO0 GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# DIC# VSS RW#(WR# E(RD#) VDD DD	-271.275 -195.075 -118.875 -42.675 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 5719.325 795.525 871.725 947.925 1176.525 1176.525 1252.725 1328.925 1405.125 1481.325	672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 70 71 72 73 74 75 76 77 78 79 80 81	RESE VBREF BGGND VSS VCC GMO0 GPMO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS FR CL DOF# VSS FR RES# DVS RES# DVS RES# DVS RES# DVS RUS RW#(WR#) VDD D0 D0	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 1024.125 1100.325 1176.525 1252.725 1328.925 1481.325 1481.325 1557.525	672.075 672.075
56 57 58 58 59 60 61 62 63 64 65 66 67 70 77 77 77 77 77 78 79 80 81 82	RESE VBREF BGGNID VSS VCC GPIO0 GBIO0 BS0 VSS BS1 VDD BS0 VSS FR CL DOF# VSS FR CL DOF# VSS FR CL DOF# CS# CS# RES# DIC# DIC# DIC# DIC# DIC# DIC# DIC# DIC	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 414.525 490.725 566.925 643.125 795.525 871.725 947.925 1024.125 1176.525 1176.525 1328.925 1405.125 1481.325 1481.325 1481.325 1481.325 1557.525	672.075 -672.075
56 57 58 59 60 61 62 63 66 66 67 70 71 72 73 74 75 76 80 81 81 82 83	RESE VBRET BGGND VSS VCC GPHO01 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# DIC# VSS RVSS RVSS RVSS CS# DIC# DIC# VDD DI D	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 947.925 1024.125 1176.525 1176.525 1252.725 1481.325 1481.325 1481.325 1481.325 1481.325 1481.325 1799.925 1799.925	672.075 672.075
56 57 58 59 60 61 62 63 64 65 66 66 67 72 73 74 75 76 77 78 79 80 81 82 83	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS FR CL DOF# VSS FR CL DOF# USS F	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325 795.525 871.725 947.925 1024.125 1100.325 1176.525 1328.925 1405.125 1405.125 1406.125 1407.925 1408.125 1408.125 1409.125	672.075 672.075
56 57 58 59 60 61 62 63 66 67 68 69 70 71 72 73 74 75 80 81 82 83 84 85	RESE VBREF BGGNID VSS GPIO0 GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# CS# DIC# VSS RES# DIC# DIC# DIC# DIC# DIC# DIC# DIC# DIC	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325 795.525 1024.125 1170.325 1176.525 1252.738.925 1405.125 1176.525 1252.738.925 1405.125 1252.738.925 1405.125 1252.738.925 1405.125 1252.738.925 1405.125 1252.738.925 1405.125 1252.738.925 1405.125 1252.738.925 1405.125 1252.738.925 1481.325 1481.325 1481.325 1481.325 1481.325 1481.325 1481.325 1481.325 1481.325 1481.325	672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 70 71 77 78 79 80 81 82 83 84 85 86	RESE VBREF BGGND VSS VCC GHOO GPIOI VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# RES# DVSS RES# DVSS RW#(WR#) E(RD#) VDD D1 D2 D3 D4 D5 D6	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 100.325 1176.525 1252.725 1481.325 1481.325 1490.725 1481.325 1490.725 1481.325 1490.725 1481.325 1481.325 1790.925 1790.925 1786.125 1862.325 1938.525	672.075 672.075
56 57 58 59 60 61 62 63 64 65 66 67 71 72 73 74 75 76 77 78 80 81 82 83 84 85 86 87	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# RES# DIC# VSS RES# DIC# VSS RES# DIC# DD	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325 795.525 871.725 947.925 1100.325 1176.525 1100.325 1176.525	672.075 672.075
56 57 58 59 60 61 62 63 64 65 66 67 70 71 72 73 74 75 76 80 81 81 82 83 84 85 88	RESE VBREF BGGND VSS GPHO0 GPHO0 GPHO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS FR CL DOF# VSS FR CL DOF# USS	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 795.525 871.725 947.925 1176.525 1176.525 1252.725 1252.725 1405.125 1405.125 1405.125 1557.525 1633.725 1481.325 1557.525 1686.125 1786.125 1862.325 1786.125 1938.525 2014.725 2090.925 2167.125	672.075 -672.075
56 57 58 59 60 61 62 63 64 65 66 67 71 72 73 74 75 76 77 78 80 81 82 83 84 85 86 87	RESE VBREF BGGND VSS VCC GPIO0 GPIO1 VDD BS0 VSS BS1 VDD BS2 VSS FR CL DOF# VSS CS# RES# DIC# VSS RES# DIC# VSS RES# DIC# DD	-271.275 -195.075 -118.875 -42.675 -33.525 109.725 185.925 262.125 338.325 414.525 490.725 566.925 643.125 719.325 795.525 871.725 947.925 1100.325 1176.525 1100.325 1176.525	672.075 672.075

Pad#	Signal	X-pos 2395.725	Y-pos -672.075
91	ICAS	2395.725	-672.075
93	IREF	2548.125	-672.075
94	VCOMH	2624.325	-672.075
95	VCOMH	2700.525	-672.075
96	VREF	2776.725	-672.075
97	VCC	2852.925	-672.075
98	VCC	2929.125	-672.075
99	VDD	3005.325	-672.075
100	VSL	3081.525	-672.075
101	VSS	3157.725	-672.075
102	VCL	3233.925	-672.075
103	VCL	3310.125	-672.075
104	VCL	3386.325	-672.075
105	DUMMY	3462.525	-672.075
106	DUMMY	3538.725	-672.075
107	DUMMY	3614.925	-672.075
108	DUMMY	3691.125	-672.075
109	DUMMY	3767.325	-672.075 -672.075
110	DUMMY	3843.525	
111 112	DUMMY	3919.725	-672.075
	DUMMY	3995.925	-672.075
113	DUMMY	4072.125	-672.075
114 115	DUMMY	4148.325 4224.525	-672.075 -672.075
115	DUMMY	4224.525	-672.075
117	DUMMY	4300.725	-672.075
118	DUMMY	4453.125	-672.075
119	DUMMY	4529.325	-672.075
120	DUMMY	4605.525	-672.075
121	DUMMY	4681.725	-672.075
122	DUMMY	4757.925	-672.075
123	COM39	5102.400	-672.075
124	COM38	5154.200	-672.075
125	COM37	5206.000	-672.075
126	COM36	5257.800	-672.075
127	COM35	5309.600	-672.075
128	DUMMY	5361.800	-672.075
129	DUMMY	5414.000	-672.075
130	DUMMY	5414.000	672.075
131	DUMMY	5361.800	672.075
132	COM34	5309.600	672.075
133	COM33	5257.800	672.075
134	COM32	5206.000	672.075
135	COM31	5154.200	672.075
136	COM30	5102.400	672.075
137 138	COM29	5050.600	672.075
138	COM28	4998.800	672.075
140	COM27	4947.000 4895.200	672.075 672.075
141	COM25	4843.400	672.075
142	COM24	4791.600	672.075
143	COM23	4739.800	672.075
144	COM22	4688.000	672.075
145	COM21	4636.200	672.075
146	COM20	4584.400	672.075
147	COM19	4532.600	672.075
148	COM18	4480.800	672.075
149	COM17	4429.000	672.075
150	COM16	4377.200	672.075
151	COM15	4325.400	672.075
152	COM14	4273.600	672.075
153	COM13	4221.800	672.075
154	COM12	4170.000	672.075
155	COM11	4118.200	672.075
156	COM10	4066.400	672.075
157	COM9	4014.600	672.075
158	COM8	3962.800	672.075
159	COM7	3911.000	672.075
160	COM6	3859.200	672.075
161	COM5	3807.400	672.075
162	COM4	3755.600	672.075
163	COM3	3703.800	672.075
164	COM2	3652.000 3600.200	672.075
165	COM1 COM0		672.075
166	SEG0	3548.400	672.075
167 168	SEG0 SEG1	3340.800	672.075 672.075
168	SEG1 SEG2	3288.600	
170	SEG2 SEG3	3236.400 3184.200	672.075 672.075
171	SEG3		
171	SEG4 SEG5	3132.000 3079.800	672.075 672.075
173	SEG5 SEG6	3079.800	672.075
			672.075
174 175	SEG7 SEG8	2975.400	672.075
175	SEG8 SEG9	2923.200 2871.000	672.075
177	SEG10	2818.800	672.075
178	SEG10	2766.600	672.075
	SEG11	2714.400	672.075
179			

Pad#	Signal	X-pos	Y-pos 672.075
181	SEG14	2610.000	672.075
182 183	SEG15 SEG16	2557.800 2505.600	672.075 672.075
184	SEG17	2453.400	672.075
185	SEG18	2401.200	672.075
186	SEG19	2349.000	672.075
187 188	SEG20 SEG21	2296.800 2244.600	672.075 672.075
189	SEG22	2192.400	672.075
190	SEG23	2140.200	672.075
191	SEG24	2088.000	672.075
192 193	SEG25 SEG26	2035.800 1983.600	672.075 672.075
194	SEG27	1931.400	672.075
195	SEG28	1879.200	672.075
196	SEG29	1827.000	672.075
197 198	SEG30 SEG31	1774.800 1722.600	672.075 672.075
199	SEG32	1670.400	672.075
200	SEG33	1618.200	672.075
201	SEG34	1566.000	672.075
202 203	SEG35 SEG36	1513.800 1461.600	672.075 672.075
203	SEG37	1409.400	672.075
205	SEG38	1357.200	672.075
206	SEG39	1305.000	672.075
207 208	SEG40 SEG41	1252.800 1200.600	672.075 672.075
208	SEG41	1200.600	672.075
210	SEG43	1096.200	672.075
211	SEG44	1044.000	672.075
212 213	SEG45 SEG46	991.800 939.600	672.075 672.075
214	SEG47	887.400	672.075
215	SEG48	835.200	672.075
216	SEG49	783.000	672.075
217 218	SEG50 SEG51	730.800	672.075 672.075
219	SEG51	678.600 626.400	672.075
220	SEG53	574.200	672.075
221	SEG54	522.000	672.075
222	SEG55	469.800	672.075
223 224	SEG56 SEG57	417.600 365.400	672.075 672.075
225	SEG58	313.200	672.075
226	SEG59	261.000	672.075
227	SEG60	208.800	672.075
228 229	SEG61 SEG62	156.600 104.400	672.075 672.075
230	SEG63	52.200	672.075
231	SEG64	0.000	672.075
232	SEG65	-52.200	672.075
233 234	SEG66 SEG67	-104.400 -156.600	672.075 672.075
235	SEG68	-208.800	672.075
236	SEG69	-261.000	672.075
237	SEG70	-313.200	672.075
238 239	SEG71 SEG72	-365.400 -469.800	672.075 672.075
240	SEG73	-522.000	672.075
241	SEG74	-574.200	672.075
242	SEG75	-626.400	672.075
243 244	SEG76 SEG77	-678.600 -730.800	672.075 672.075
245	SEG78	-783.000	672.075
246	SEG79	-835.200	672.075
247 248	SEG80 SEG81	-887.400	672.075
249	SEG82	-939.600 -991.800	672.075 672.075
250	SEG83	-1044.000	672.075
251	SEG84	-1096.200	672.075
252 253	SEG85 SEG86	-1148.400 -1200.600	672.075 672.075
253	SEG87	-1252.800	672.075
255	SEG88	-1305.000	672.075
256	SEG89	-1357.200	672.075
257 258	SEG90 SEG91	-1409.400 -1461.600	672.075 672.075
259	SEG91	-1461.800	672.075
260	SEG93	-1566.000	672.075
261	SEG94	-1618.200	672.075
262 263	SEG95 SEG96	-1670.400 -1722.600	672.075 672.075
263	SEG96 SEG97	-1722.600	672.075
265	SEG98	-1827.000	672.075
266	SEG99	-1879.200	672.075
267 268	SEG100 SEG101	-1931.400 -1983.600	672.075 672.075
269	SEG101	-1983.600	672.075
270	SEG103	-2088.000	672.075

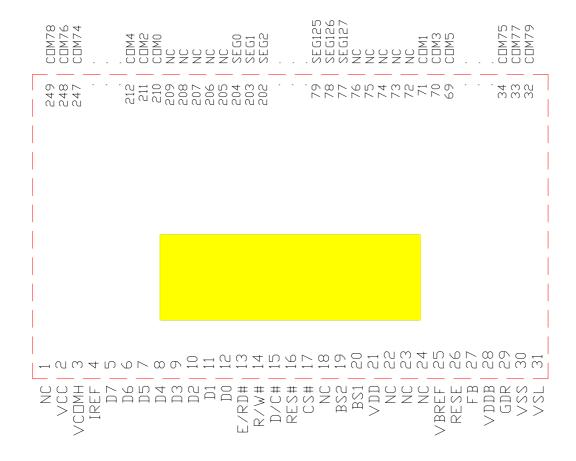
Pad#	Signal	X-pos	Y-pos
271	SEG104	-2140.200	672.075
272	SEG105	-2192.400	672.075
273	SEG106	-2244.600	672.075
274	SEG107	-2296.800	672.075
275	SEG108	-2349.000	672.075
276	SEG109	-2401.200	672.075
277	SEG110	-2453,400	672.075
278	SEG111	-2505,600	672.075
279	SEG112	-2557.800	672.075
280	SEG113	-2610.000	672.075
281	SEG114	-2662.200	672.075
282	SEG115	-2714.400	672.075
283	SEG116	-2766.600	672.075
284	SEG117	-2818.800	672.075
285	SEG118	-2871.000	672.075
286	SEG119	-2923.200	672.075
287	SEG119	-2925.200	672.075
288	SEG120 SEG121		
		-3027.600	672.075
289	SEG122	-3079.800	672.075
290	SEG123	-3132.000	672.075
291	SEG124	-3184.200	672.075
292	SEG125	-3236.400	672.075
293	SEG126	-3288.600	672.075
294	SEG127	-3340.800	672.075
295	COM40	-3548.400	672.075
296	COM41	-3600.200	672.075
297	COM42	-3652.000	672.075
298	COM43	-3703.800	672.075
299	COM44	-3755.600	672.075
300	COM45	-3807.400	672.075
301	COM46	-3859.200	672.075
302	COM47	-3911.000	672.075
303	COM48	-3962.800	672.075
304	COM49	-4014.600	672.075
305	COM50	-4066,400	672.075
306	COM51	-4118.200	672.075
307	COM52	-4170.000	672.075
308	COM53	-4221.800	672.075
309	COM54	-4273.600	672.075
310	COM55	-4325.400	672.075
311	COM56	-4377.200	672.075
312	COM57	-4429.000	672.075
313	COM58	-4480.800	672.075
314	COM59	-4532.600	672.075
315	COM60	-4584.400	672.075
316	COM61	-4564.400	672.075
316	COM62	-4688.000	672.075
317	COM63		672.075
		-4739.800	
319	COM64	-4791.600	672.075
320	COM65	-4843.400	672.075
321	COM66	-4895.200	672.075
322	COM67	-4947.000	672.075
323	COM68	-4998.800	672.075
324	COM69	-5050.600	672.075
325	COM70	-5102.400	672.075
326	COM71	-5154.200	672.075
327	COM72	-5206.000	672.075
328	COM73	-5257.800	672.075
329	COM74	-5309.600	672.075
330	DUMMY	-5361.800	672.075
331	DUMMY	-5414.000	672.075

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6 PIN ARRANGEMENT

6.1 SSD1325T6R1 pin assignment

Figure 4: SSD1325T6R1 Pin Assignment



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Table 3: SSD1325T6R1 TAB Pin assignment Table

DIXIXIZ							DININIANA
PIN NO.	PIN NAME NC	PIN NO.	PIN NAME SEG123	PIN NO. 161	PIN NAME SEG43	PIN NO. 241	PIN NAME COM62
2	VCC	82	SEG123	162	SEG42	241	COM64
3	VCOMH	83	SEG121	163	SEG41	243	COM66
4	IREF	84	SEG120	164	SEG40	244	COM68
5	D7	85	SEG119	165	SEG39	245	COM/0
<u>6</u> 7	D6 D5	86 87	SEG118 SEG117	166 167	SEG38 SEG37	246	COM74
8	D3	88	SEG116	168	SEG36	247 248	COM76
9	D3	89	SEG115	169	SEG35	249	COM/8
10	D2	90	SEG114	170	SEG34		
11	D1	91	SEG113	171	SEG33		
12	D0 E/RD#	92	SEG112 SEG111	172	SEG32 SEG31		
13 14	R/W#	93 94	SEG110	173 174	SEG30		
15	D/C#	95	SEG109	175	SEG29		
16	RES#	96	SEG108	176	SEG28		
17	CS#	97	SEG107	177	SEG27		
18	NC BS2	98 99	SEG106 SEG105	178	SEG26 SEG25		
19 20	BS1	100	SEG103	179 180	SEG23		
21	VDD	101	SEG103	181	SEG23		
22	NC	102	SEG102	182	SEG22		
23	NC	103	SEG101	183	SEG21		
24	NC VBBEE	104	SEG100	184	SEG20		
25 26	VBREF RESE	105 106	SEG99 SEG98	185 186	SEG19 SEG18	ĺ	
27	FR	106	SEG97	187	SEG17	ĺ	
28	VDDB	108	SEG96	188	SEG16		
29	GDR	109	SEG95	189	SEG15		
30	VSS VSL	110	SEG94 SEG93	190	SEG14 SEG13	ĺ	
31 32	COM79	111 112	SEG93 SEG92	191 192	SEG13 SEG12		
33	COM77	113	SEG92 SEG91	192	SEG12		
34	COM/5	114	SEG90	194	SEG10		
35	COM73	115	SEG89	195	SEG9		
36	COM71	116	SEG88	196	SEG8		
37 38	COV69 COV67	117 118	SEG87 SEG86	197 198	SEG7 SEG6		
39	COV65	119	SEG85	196	SEG5		
40	COV63	120	SEG84	200	SEG4		
41	COV61	121	SEG83	201	SEG3		
42	COM59	122	SEG82	202	SEG2		
43	COV57 COV55	123 124	SEG81 SEG80	203 204	SEG1 SEG0		
45	COV53	125	SEG79	205	NC		
46	COM51	126	SEG78	206	NC		
47	COM49	127	SEG77	207	NC		
48	COM7	128	SEG76 SEG75	208	NC NC		
49 50	COV45 COV43	129 130	SEG73	209 210	COM0		
51	COV#1	131	SEG73	211	COM2		
52	COMB9	132	SEG72	212	COM4		
53	COMB7	133	SEG71	213	COM6	ĺ	
<u>54</u> 55	COVB5 COVB3	134	SEG70 SEG69	214	COM8 COM10		
56	COVB3	135 136	SEG68	215 216	COM10		
57	COV29	137	SEG67	217	COM14	ĺ	
58	COM27	138	SEG66	218	COM16		
59	COV25	139	SEG65	219	COM18	ĺ	
60 61	COV23 COV21	140 141	SEG64 SEG63	220 221	COM20 COM22		
62	COM19	141	SEG62	221	COM24	ĺ	
63	COVI 7	143	SEG61	223	COM26		
64	COM15	144	SEG60	224	COM28	ĺ	
65	COM13	145	SEG59 SEG58	225	COM30 COM32		
<u>66</u> 67	COM11 COM9	146 147	SEG58 SEG57	226 227	COM32 COM34	ĺ	
68	COM	148	SEG56	228	COM36	ĺ	
69	COM5	149	SEG55	229	COM38		
70	COMB	150	SEG54	230	COM40	ĺ	
71	COMI	151 152	SEG53 SEG52	231	COM42 COM44		
72 73	NC NC	152 153	SEG52 SEG51	232 233	COM46	ĺ	
74	NC NC	154	SEG50	234	COM48		
75	NC	155	SEG49	235	COM50	ĺ	
76	NC SEQUAT	156	SEG48	236	COM52		
77 78	SEG127 SEC126	157	SEG47 SEG46	237	COM54 COM56	ĺ	
76 79	SEG126 SEG125	158 159	SEG45	238 239	COM58		
80	SEG124	160	SEG44	240	COM60		

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7 PIN DESCRIPTION

Key:

I = Input	NC = Not Connected
O = Output	Pull LOW = Connect to Ground
IO = Bi-directional (input/output)	Pull HIGH = Connect to V_{DD}
P = Power pin	

Table 4: Pin Descriptions

Pin Name	Pin Type	Description							
RES#	Ι		This pin is reset signal input. When the pin is LOW, initialization of the chip is executed. Keep this pin HIGH during normal operation.						
CS#	Ι		This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled LOW.						
D/C#	I	treated as da command re	This pin is Data/Command control pin. When the pin is pulled HIGH, the data at D[7:0] is treated as data. When the pin is pulled LOW, the data at D[7:0] will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams in Figure 34 to Figure 37.						
E (RD#)	I	pin will be u pulled HIGH When conne	This pin is MCU interface input. When interfacing to a 6800-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled HIGH and the chip is selected. When connecting to an 8080-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled LOW and the chip is selected.						
R/W# (WR#)	I	pin will be u when this pin When 8080	sed as Ron is pulle interface	rface input. When it ead/Write (R/W#) stand HIGH and write mode is selected, the when this pin is pulled.	election input. Rea mode will be carrie his pin will be the V	nd mode will be can ed out when LOW. Write (WR#) input	ried out		
D[7:0]	IO		erial mod	oi-directional data b de is selected, D1 w SCLK.					
BS[2:0]	I	-		bus interface select	ion.				
		Table 5 : Bu	is interi	ace selection					
				6800-parallel interface (8 bit)	8080-parallel interface (8 bit)	Serial interface			
			BS0	0	0	0			
			BS1	0	1	0			
			BS2	1	1	0			
		Note (1) 0 is conne (2) 1 is conne	ected to Vected to V	Vss V _{DD}					
V_{DD}	P	This is a pov	This is a power supply pin. It must be connected to external source.						
V_{SS}	P	This is a gro		It also acts as grougeround.	nd reference for the	e logic pins. It mus	st be		
CL	Ю			n clock input. When wes display clock sign					

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Pin Name	Pin Type	Description
		clock is enabled (i.e. CLS is pulled HIGH), this pin should be kept NC and left open.
CLS	I	This is the internal clock enable pin. When this pin is pulled HIGH, internal oscillator is selected. The internal clock will be disabled when it is pulled LOW, an external clock source must be connected to CL pin for normal operation.
V _{CC}	P	This pin is the most positive voltage supply of the chip. It is supplied by external high voltage source.
V _{COMH}	P	A capacitor should be connected between this pin and $V_{\rm SS}$. No external power supply is allowed to connect to this pin.
I_{REF}	I	This pin is the segment output current reference pin. I_{SEG} is derived from I_{REF} . A resistor should be connected between this pin and V_{SS} to maintain the current around 10uA.
COM0 ~ COM79	О	These pins provide the Common switch signals to the OLED panel. These pins are in high impedance state when display is OFF.
SEG0 ~ SEG127	О	These pins provide the OLED segment driving signals. These pins are in high impedance state when display is OFF.
V_{REF}	P	This pin is the voltage reference for the pre-charge voltage in driving OLED device. Voltage should be set matching with the OLED driving voltage in the current drive phase. It can be either supplied externally or connected to V_{CC} .
VCL	О	This is the output pin for the voltage output low level for COM signals. This pin should be connected to $V_{\text{SS.}}$
VSL	О	This is the output pin for the voltage output low level for SEG signals. This pin can be kept NC or connected with a capacitor to V_{SS} for stability. Refer to command BFh for VSL pin connection details.
VSLCAP	0	This is a reserved pin. It has to be kept NC and left open.
M/S#	I	This pin is an input pin and must be pulled HIGH to enable the chip function.
VDDB	P	This is a reserved pin. It should be connected to V_{DD} .
VSSB	P	This is a reserved pin. It should be connected to V_{SS} .
GDR	0	This is a reserved pin. It should be kept NC.
RESE	Ι	This is a reserved pin. It should be kept NC.
FB	I	This is a reserved pin. It should be kept NC.
VBREF	I	This is an internal voltage reference pin. It should be kept NC and left open.
FR	-	It is No Connection pin. It should be kept NC and left open.
DOF#	-	It is No Connection pin. It should be kept NC and left open.
GPIO0	IO	This is a reserved pin. It should be kept NC and left open.
GPIO1	IO	This is a reserved pin. It should be kept NC and left open.
<u> </u>		1

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Pin Name	Pin Type	Description
TR[8:0]	-	This is a reserved pin. It should be kept NC and left open.
ICAS	-	This is a reserved pin. It should be kept NC and left open.

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8 FUNCTIONAL BLOCK DESCRIPTIONS

8.1 MCU Interface selection

SSD1325 MCU interface consist of 8 data pins and 5 control pins. The pin assignment at different interface mode is summarized in Table 6. Different MCU mode can be set by hardware selection on BS[2:0] pins (please refer to Table 5 for BS[2:0] setting).

Table 6: MCU interface assignment under different bus interface mode

	Data/	Data/Command Interface								Control Signal				
Bus Interface	D7	07 D6 D5 D4 D3 D2 D1 D0 E R/W# CS#							D/C#	RES#				
8-bit 8080							RD#	WR#	CS#	D/C#	RES#			
8-bit 6800		D[7:0]						Е	R/W#	CS#	D/C#	RES#		
SPI	Tie LO	OW				NC	SDIN	SCLK	Tie LC	W	CS#	D/C#	RES#	

8.1.1 MCU Parallel 6800-series Interface

The parallel interface consists of 8 bi-directional data pins (D[7:0]), R/W#, D/C#, E and CS#.

A LOW in R/W# indicates WRITE operation and HIGH in R/W# indicates READ operation. A LOW in D/C# indicates COMMAND read/write and HIGH in D/C# indicates DATA read/write. The E input serves as data latch signal while CS# is LOW. Data is latched at the falling edge of E signal.

Table 7: Control pins of 6800 interface

Function	E	R/W#	CS#	D/C#
Write command	\downarrow	L	L	L
Read status	↓	Н	L	L
Write data	↓	L	L	Н
Read data	\downarrow	Н	L	Н

Note

L stands for LOW in signal

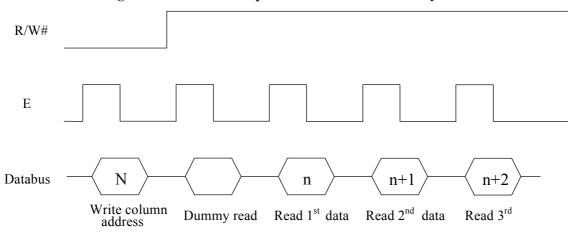
In order to match the operating frequency of display RAM with that of the microprocessor, some pipeline processing is internally performed which requires the insertion of a dummy read before the first actual display data read. This is shown in Figure 5.

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<sup>(1)

↓</sup> stands for falling edge of signal H stands for HIGH in signal

Figure 5: Data read back procedure - insertion of dummy read



8.1.2 MCU Parallel 8080-series Interface

The parallel interface consists of 8 bi-directional data pins (D[7:0]), RD#, WR#, D/C# and CS#.

A LOW in D/C# indicates COMMAND read/write and HIGH in D/C# indicates DATA read/write. A rising edge of RD# input serves as a data READ latch signal while CS# is kept LOW. A rising edge of WR# input serves as a data/command WRITE latch signal while CS# is kept LOW.

Figure 6: Example of Write procedure in 8080 parallel interface mode

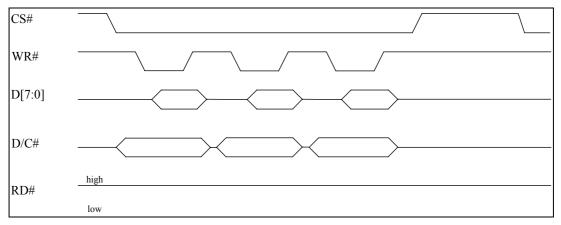
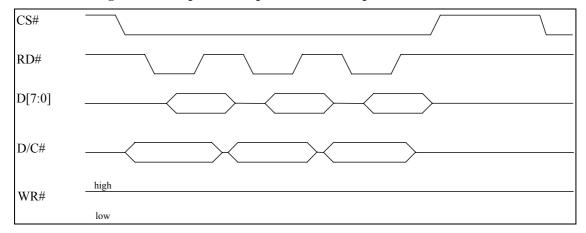


Figure 7: Example of Read procedure in 8080 parallel interface mode



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Table 8: Control pins of 8080 interface (Form 1)

Function	RD#	WR#	CS#	D/C#
Write command	Н	1	L	L
Read status	1	Н	L	L
Write data	Н	1	L	Н
Read data	1	Н	L	Н

Note

Alternatively, RD# and WR# can be keep stable while CS# serves as the data/command latch signal.

Table 9: Control pins of 8080 interface (Form 2)

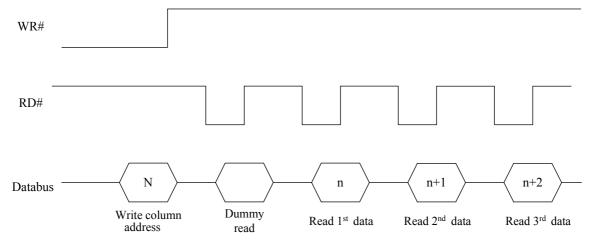
Function	RD#	WR#	CS#	D/C#
Write command	Н	L	1	L
Read status	L	Н	1	L
Write data	Н	L	↑	Н
Read data	L	Н	↑	Н

Note

- (1) ↑ stands for rising edge of signal
- (2) H stands for HIGH in signal
- (3) L stands for LOW in signal

In order to match the operating frequency of display RAM with that of the microprocessor, some pipeline processing is internally performed which requires the insertion of a dummy read before the first actual display data read. This is shown in Figure 8.

Figure 8: Display data read back procedure - insertion of dummy read



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^{(1) ↑} stands for rising edge of signal

⁽²⁾ H stands for HIGH in signal

⁽³⁾ L stands for LOW in signal

⁽⁴⁾ Refer to Figure 35 for Form 1 8080-Series MCU Parallel Interface Timing Characteristics

⁽⁴⁾ Refer to Figure 36 for Form 2 8080-Series MCU Parallel Interface Timing Characteristics

8.1.3 MCU Serial Interface

The serial interface consists of serial clock SCLK, serial data SDIN, D/C#, CS#. In SPI mode, D0 acts as SCLK, D1 acts as SDIN. For the unused data pins, D2 should be left open. The pins from D3 to D7, E and R/W# can be connected to an external ground.

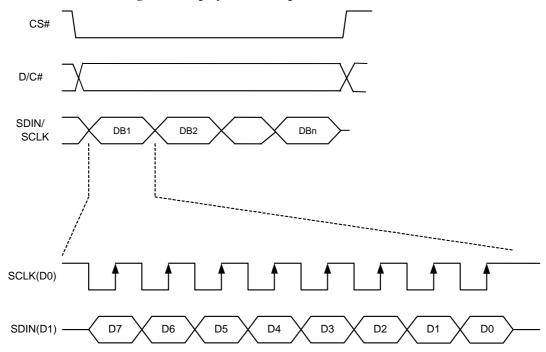
Table 10: Control pins of Serial interface

Function	E	R/W#	CS#	D/C#
Write command	Tie LOW	Tie LOW	L	L
Write data	Tie LOW	Tie LOW	L	Н

SDIN is shifted into an 8-bit shift register on every rising edge of SCLK in the order of D7, D6, ... D0. D/C# is sampled on every eighth clock and the data byte in the shift register is written to the Graphic Display Data RAM (GDDRAM) or command register in the same clock.

Under serial mode, only write operations are allowed.

Figure 9: Display data write procedure in SPI mode



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8.2 Segment Drivers/Common Drivers

Segment drivers have 128 current sources to drive OLED panel. The driving current can be adjusted from 0 to 300uA with 7 bits, 128 steps. Common drivers generate voltage scanning pulses. The block diagrams and waveforms of the segment and common driver are shown as follow.

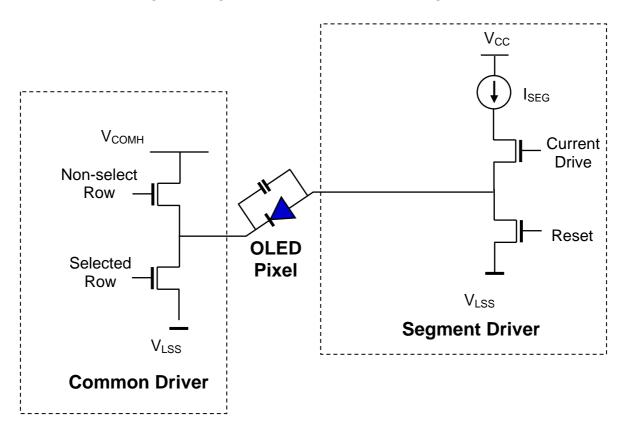


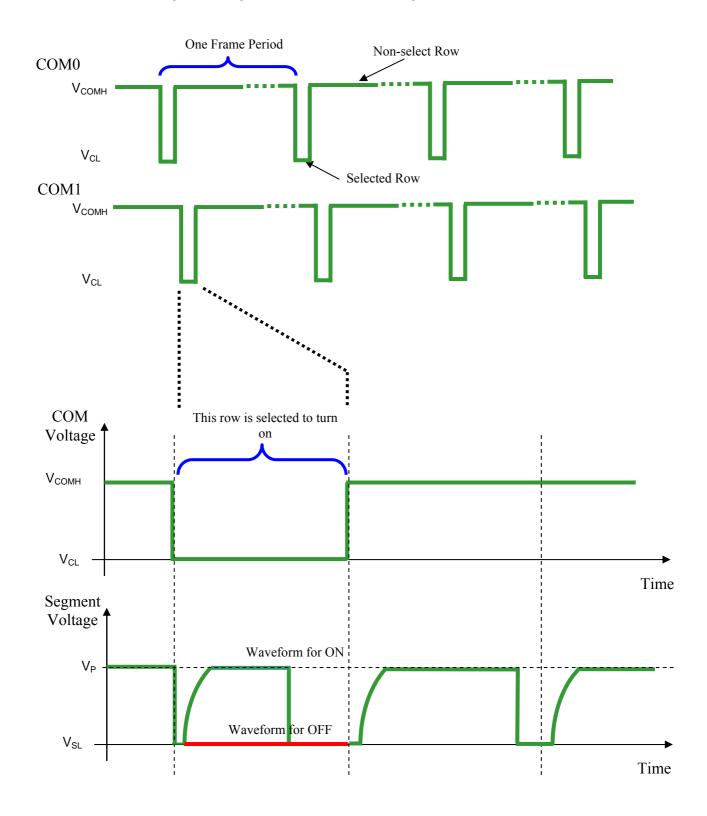
Figure 10 : Segment and Common Driver Block Diagram

The commons are scanned sequentially, row by row. If a row is not selected, all the pixels on the row are in reverse bias by driving those commons to voltage V_{COMH} as shown in Figure 11.

In the scanned row, the pixels on the row will be turned ON or OFF by sending the corresponding data signal to the segment pins. If the pixel is turned OFF, the segment current is kept at 0. On the other hand, the segment drives to I_{SEG} when the pixel is turned ON.

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Figure 11: Segment and Common Driver Signal Waveform



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There are three phases to driving an OLED a pixel. In phase 1, the pixel is reset by the segment driver to V_{SS} in order to discharge the previous data charge stored in the parasitic capacitance along the segment electrode. The period of phase 1 can be programmed by command B1h A[3:0] from 1 to 15 DCLK. An OLED panel with larger capacitance requires a longer period for discharging.

In phase 2, pre-charge is performed. The pixel is driven to attain the corresponding voltage level V_P from V_{SS} . The amplitude of V_P can be programmed by the command BCh. The period of phase 2 can be programmed in length from 1 to 15 DCLK by command B1h A[7:4]. If the capacitance value of the pixel of OLED panel is larger, a longer period is required to charge up the capacitor to reach the desired voltage.

Last phase (phase 3 is current drive stage. The current source in the segment driver delivers constant current to the pixel. The driver IC employs PWM (Pulse Width Modulation) method to control the gray scale of each pixel individually. The wider pulse widths in the current drive stage results in brighter pixels and vice versa. This is shown in the following figure.

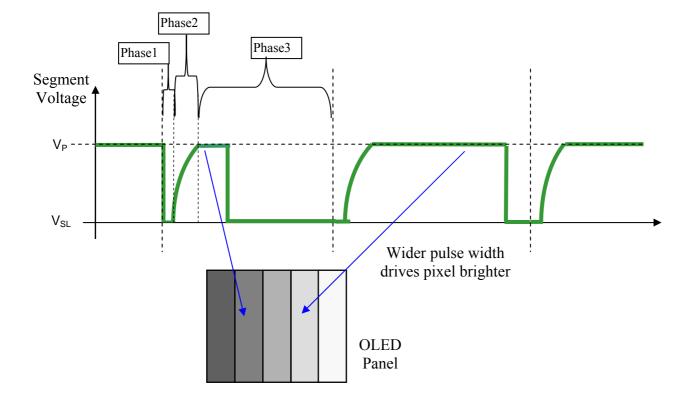


Figure 12: Gray Scale Control by PWM in Segment

After finishing phase 3, the driver IC will go back to phase 1 to display the next row image data. This three-step cycle is run continuously to refresh image display on OLED panel.

The pulse width, which is counted from Phase 2 to Phase 3, is defined by command B8h "Set Gray Scale Table". In the table, the gray scale is defined in incremental way, with reference to the length of previous table entry.

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8.3 Oscillator Circuit and Display Time Generator

This module is an On-Chip low power RC oscillator circuitry. The operation clock (CLK) can be generated either from internal oscillator or external source CL pin. This selection is done by CLS pin. If CLS pin is pulled HIGH, internal oscillator is chosen and CL should be left open. Pulling CLS pin LOW disables internal oscillator and external clock must be connected to CL pins for proper operation. When the internal oscillator is selected, its output frequency F_{OSC} can be changed by command B3h, please refer to Table 18.

Internal Oscillator Fosc

CL

MUX

Divider

Display Clock

Figure 13: Oscillator Circuit

The display clock (DCLK) for the Display Timing Generator is derived from CLK. The division factor "D" can be programmed from 1 to 16 by command B3h

$$DCLK = F_{OSC} / D$$

The frame frequency of display is determined by the following formula.

$$F_{FRM} = \frac{F_{osc}}{D \times K \times No. \text{ of Mux}}$$

where

- D stands for clock divide ratio. It is set by command B3h A[3:0]. The divide ratio has the range from 1 to 16
- K is row period. It is configured by command B2h. This value should comply with following condition.

$$K \ge Phase 1 + Phase 2 + Phase 3 + GS15$$

- Number of multiplex ratio is set by command A8h. The power ON reset value is 4Fh.
- F_{OSC} is the oscillator frequency. It can be changed by command B3h A[7:4]. The higher the register setting results in faster frequency.

If the frame frequency is set too low, flickering may occur. On the other hand, higher frame frequency leads to higher power consumption on the whole system.

8.4 Command Decoder and Command Interface

This module determines whether the input data is interpreted as data or command. Data is interpreted based upon the input of the D/C# pin.

If D/C# pin is HIGH, the input at D_7 - D_0 is written to Graphic Display Data RAM (GDDRAM). If it is LOW, the input at D_7 - D_0 is interpreted as a Command which will be decoded and be written to the corresponding command register.

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8.5 Reset Circuit

When RES# input is LOW, the chip is initialized with the following status:

- 1. Display is OFF
- 2. 128 x 80 Display Mode
- 3. Normal segment and display data column address and row address mapping (SEG0 mapped to address 00h and COM0 mapped to address 00h)
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 40h

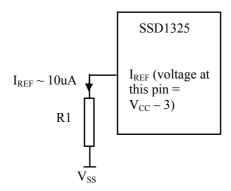
8.6 Current Control and Voltage Control

This block is used to derive the incoming power sources into the different levels of internal use voltage and current.

- V_{DD} is an external voltage supply.
- V_{CC} is the most positive external voltage supply.
- V_{COMH} is the Common deselected level. It is internally regulated.
- V_{SS} is the ground path of the analog and panel current.
- I_{REF} is a reference current source for segment current drivers I_{SEG}.

Note that V_{REF} is reference voltage, which is used to derive driving voltage for segments and commons. The magnitude of I_{REF} is controlled by the value of resistor, which is connected between I_{REF} pin and Vss as shown in Figure 14. It is recommended to set I_{REF} to 10uA+/-2uA so as to achieve $I_{SEG} = 300uA$ at maximum contrast 127.

Figure 14: I_{REF} Current Setting by Resistor Value



Since the voltage at I_{REF} pin is $V_{CC} - 3V$, the value of resistor R1 can be found as below. R1 = (Voltage at $I_{REF} - V_{SS}$) / $I_{REF} = (V_{CC} - 3)$ / $10uA \approx 910k\Omega$ for $V_{CC} = 12V$.

8.7 Graphic Display Data RAM (GDDRAM)

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 128x80x4 bits. For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software. The GDDRAM address maps in

Table 11 to Table 15 show some examples on using the command "Set Re-map" A0h to re-map the GDDRAM. In the following tables, the lower nibble and higher nibble of D0, D1, D2 ... D5117, D5118, D5119 represent the 128x80 data bytes in the GDDRAM.

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Table 11 shows the GDDRAM map under the following condition:

- Command "Set Re-map" A0h is set to:
 - Disable Column Address Re-map
 (A[0]=0)
 Disable Nibble Re-map
 (A[1]=0)
 Enable Horizontal Address Increment
 (A[2]=0)
 Disable COM Re-map
 (A[4]=0)
- Display Start Line=00h
- Data byte sequence: D0, D1, D2 ... D5119

Table 11: GDDRAM address map 1

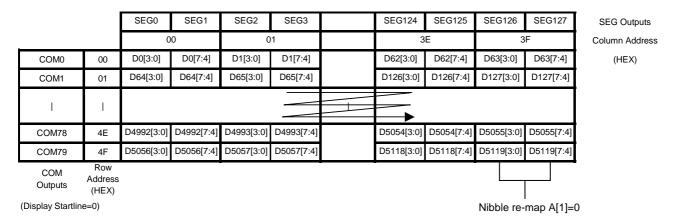


Table 12 shows the GDDRAM map under the following condition:

• Command "Set Re-map" A0h is set to:

Disable Column Address Re-map (A[0]=0)
Disable Nibble Re-map (A[1]=0)
Enable Vertical Address Increment (A[2]=1)
Disable COM Re-map (A[4]=0)

- Display Start Line=00h
- Data byte sequence: D0, D1, D2 ... D5119

Table 12: GDDRAM address map 2

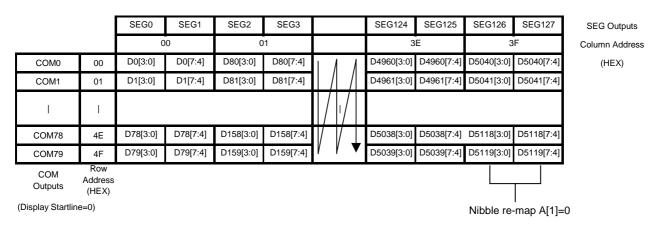


Table 13 shows the GDDRAM map under the following condition:

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- Command "Set Re-map" A0h is set to:
 - Enable Column Address Re-map (A[0]=1)
 Enable Nibble Re-map (A[1]=1)
 Enable Horizontal Address Increment (A[2]=0)
 Disable COM Re-map (A[4]=0)
- Display Start Line=00h

(Display Startline=0)

• Data byte sequence: D0, D1, D2 ... D5119

SEG1 SEG124 SEG125 SEG0 SEG2 SEG3 SEG126 SEG127 SEG Outputs 3F ററ Column Address D63[7:4] D63[3:0] D62[7:4] D62[3:0] D1[7:4] D1[3:0] D0[7:4] D0[3:0] COM0 00 (HEX) D127[3:0] D65[3:0] D64[3:0] D127[7:4] D126[7:4] D126[3:0] D65[7:4] D64[7:4] COM1 01 D5055[7:4] D5055[3:0] D5054[7:4] D5054[3:0] D4993[7:4] D4993[3:0] D4992[7:4] D4992[3:0 COM78 4E COM79 4F D5119[7:4] D5119[3:0] D5118[7:4] D5118[3:0] D5057[7:4] D5057[3:0] D5056[7:4] D5056[3:0 Row COM Address Outputs (HEX)

Table 13: GDDRAM address map 3

For vertical scrolling of the display, an internal register storing display start line can be set to control the portion of the RAM data to be mapped to the display.

Nibble re-map A[1]=1

Table 14 shows the example in which the display start line register is set to 10h with the following condition:

- Command "Set Re-map" A0h is set to:
 - Disable Column Address Re-map (A[0]=0)
 Disable Nibble Re-map (A[1]=0)
 Enable Horizontal Address Increment (A[2]=0)
 Enable COM Re-map (A[4]=1)
- Display Start Line=10h (corresponds to COM15)
- Data byte sequence: D0, D1, D2 ... D5119

Table 14: GDDRAM address map 4

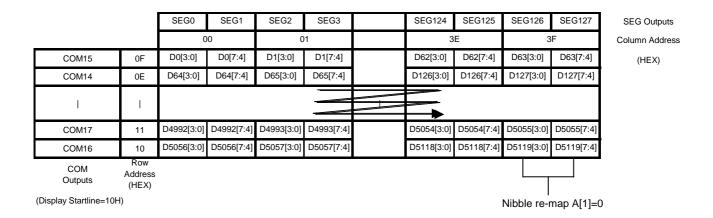


Table 15 shows the GDDRAM map under the following condition:

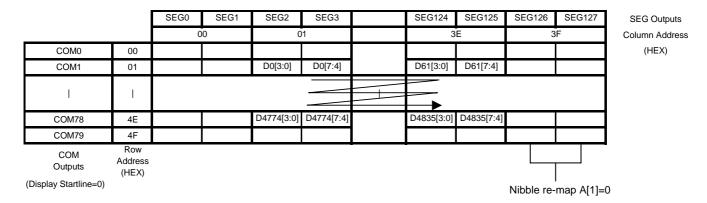
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• Command "Set Re-map" A0h is set to:

Disable Column Address Re-map
(A[0]=0)
Disable Nibble Re-map
(A[1]=0)
Enable Horizontal Address Increment
(A[2]=0)
Disable COM Re-map
(A[4]=0)

- Display Start Line=00h
- Column Start Address=01h
- Column End Address=3Eh
- Row Start Address=01h
- Row End Address=4Eh
- Data byte sequence: D0, D1, D2 ... D4835

Table 15: GDDRAM address map 5



Note

8.8 Gray Scale Decoder

There are 16 gray levels from GS0 to GS15. The gray scale of the display is defined by the pulse width (PW) of current drive phase, GS0 has no pre-charge (phase 2) and no current drive (phase 3). Each L value represents an offset to the corresponding gray scale level. See below table and graphical representation:

Table16: Gray scale pulse width set table

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^{(1]} Please refer to Table 18 for the details of setting command "Set Re-map" A0h.

⁽²⁾ The "Display Start Line" is set by the command "Set Display Start Line" A1h and please refer to Table 18 for the setting details

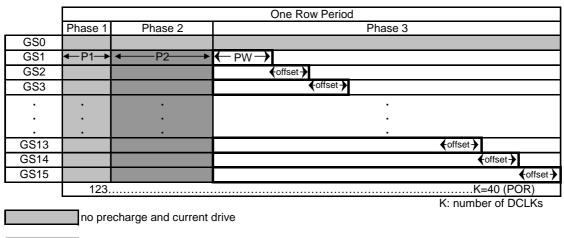
⁽³⁾ The "Column Start/End Address" is set by the command "Set Column Address" 15h and please refer to Table 18 for the setting details

⁽⁴⁾ The "Row Start/End Address" is set by the command "Set Row Address" 75h and please refer to Table 18 for the setting detail

	Description	Number of DCLKs
L1	Set GS1 level Pulse Width	0-7
L2	Set GS2 level Pulse Width Offset	1-8
L3	Set GS3 level Pulse Width Offset	1-8
•	•	•
•	•	•
•	•	•
L13	Set GS13 level Pulse Width Offset	1-8
L14	Set GS14 level Pulse Width Offset	1-8
L15	Set GS15 level Pulse Width Offset	1-8

DCLK: Internal Display Clock. It is used for defining phase clock period.

Figure 15: Gray scale pulse width set diagram



Precharge

Current Drive

Table 17: Gray scale pulse width default values

RESET	Result
L1=1	GS1 level Pulse width=1
L2=1	GS2 level Pulse width=3
L3=1	GS3 level Pulse width=5
L4=1	GS4 level Pulse width=7
L5=1	GS5 level Pulse width=9
L6=1	GS6 level Pulse width=11
L7=1	GS7 level Pulse width=13
L8=1	GS8 level Pulse width=15
L9=1	GS9 level Pulse width=17
L10=1	GS10 level Pulse width=19
L11=1	GS11 level Pulse width=21
L12=1	GS12 level Pulse width=23
L13=1	GS13 level Pulse width=25
L14=1	GS14 level Pulse width=27
L15=1	GS15 level Pulse width=29

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8.9 Power ON and OFF sequence

The following figures illustrate the recommended power ON and power OFF sequence of SSD1325. Power ON sequence:

- 1. Power ON V_{DD}.
- 2. After V_{DD} become stable, set RES# pin LOW (logic LOW) for at least 3us $(t_1)^{(4)}$ and then HIGH (logic HIGH).
- 3. After set RES# pin LOW (logic LOW), wait for at least 3us (t₂). Then Power ON V_{CC.}⁽¹⁾
- 4. After V_{CC} become stable, send command AFh for display ON. SEG/COM will be ON after 100ms $(t_{AF}).$

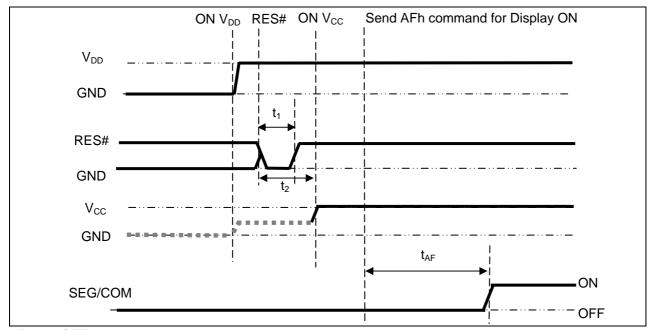


Figure 16: The Power ON sequence

Power OFF sequence:

- 1. Send command AEh for display OFF.
- 2. Wait until panel discharges completely. 3. Power OFF $V_{CC.}^{(1),(2),(3)}$
- 4. Wait for t_{OFF}. Power OFF V_{DD}. (where Minimum t_{OFF}=0ms ⁽⁵⁾ Typical t_{OFF}=100ms)

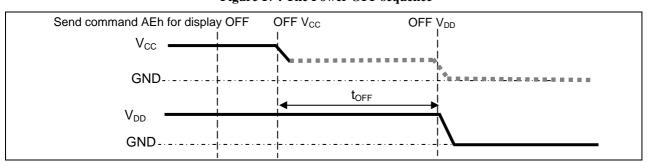


Figure 17: The Power OFF sequence

Note:

- $^{(1)}$ Since an ESD protection circuit is connected between V_{DD} and V_{CC} , V_{CC} becomes lower than V_{DD} whenever V_{DD} is ON and V_{CC} is OFF as shown in the dotted line of V_{CC} in Figure 16 and Figure 17.
- (2) V_{CC} should be kept float (disable) when it is OFF.
- Power Pins (V_{DD}, V_{CC}) can never be pulled to ground under any circumstance.
- (4) The register values are reset after t₁.
- (5) V_{DD} should not be Power OFF before V_{CC} Power OFF.

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9 COMMAND TABLE

Table 18: Command Table

(D/C# = 0, R/W# (WR#) = 0, E (RD#) = 1) unless specific setting is stated

Fund	Cundamental Command Table										
D/C						D3	D2	D 1	D 0	Command	Description
0	15	0	0	0	1	0	1	0			Second command A[5:0] sets the column start address
0	A[5:0]	*	*	\mathbf{A}_5	_	A_3	A_2	_		Set Column Figuress	from 0-63, POR = 00h
0	B[5:0]	*	*	B ₅	B ₄	B_3	B_2	\mathbf{B}_1	B_0		Third command B[5:0] sets the column end address from 0-63, RESET = 3Fh
0	75	0	1	1	1	0	1	0	1	Set Row address	Second command A[6:0]sets the row start address from
0	A[6:0]	*	A_6	A_5	A_4	A_3	A_2	\mathbf{A}_1			0-79, RESET = 00h
0	B[6:0]	*	B ₆	B ₅	B ₄	B ₃	B_2	B_1	B_0		Third command B[6:0] sets the row end address from 0-79, RESET = 4Fh
0	81	1	0	0	0	0	0	0	1	Set Contrast Current	Double byte command to select 1 out of 128 contrast
0	A[6:0]	*	A_6	A_5	A_4	A_3	\mathbf{A}_{2}	A_1	A_0		steps. Contrast increases as level increase
											The level is set to 40h after RESET
0	84~86	1	0	0	0	0	1	X_1	X_0	Set Current Range	84h = Quarter Current Range (RESET)
											85h = Half Current Range
											86h = Full Current Range
0	A0	1	0	1	0	0	0	0	0	Set Re-map	A[0]=0, Disable Column Address Re-map (RESET)
0	A[6:0]	*	A_6	A_5	A_4	A_3	A_2	\mathbf{A}_1	A_0		A[0]=1, Enable Column Address Re-map
											A[1]=0, Disable Nibble Re-map (RESET)
											A[1]=1, Enable Nibble Re-map
											A[2]=0, Horizontal Address Increment (RESET)
											A[2]=1, Vertical Address Increment
											A[4]=0, Disable COM Re-map disable (RESET)
											A[4]=1, Enable COM Re-map
											A[5]=0, Reserved (RESET)
											A[5]=1, Reserved
											A[6]=0, Disable COM Split Odd Even (RESET)
											A[6]=1, Enable COM Split Odd Even
0	A1	1	0	1	0	0	0	0	1	Set Display Start Line	Set display RAM display start line register from 0-79
0	A[6:0]	*	A_6	A_5	A_4	A_3	A_2	\mathbf{A}_1	A_0		Display start line register is reset to 00h after RESET
0	A2	1	0	1	0	0	0	1	0	Set Display Offset	Set vertical scroll by COM from 0-79
0	A[6:0]	*	A_6	A_5	A_4	A_3	A_2	\mathbf{A}_1	A_0		The value is reset to 00H after RESET

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Fund	ndamental Command Table										
D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	A4~A7	1	0	1	0	0	X_2	X_1	X_0	Set Display Mode	A4h = Normal Display (RESET)
											A5h = Entire Display ON, all pixels turns ON in GS level 15
											A6h = Entire Display OFF, all pixels turns OFF
											A7h = Inverse Display
0	A8 A[6:0]	1	0 A ₆	1 A ₅	0 A_4	1 A ₃	0 A_2	0 A_1		Set Multiplex Ratio	The next command determines multiplex ratio N from 16MUX-80MUX,
											A[6:0] = 15 represents $16MUXA[6:0] = 16$ represents $17MUX$
											A[6:0] = 78 represents 79MUX A[6:0] = 79 represents 80MUX
0 0	AD A[1:0]	1	0	1 *	0	1 *	1	0		Set Master Configuration	$A[0] = 0$, Select external V_{CC} supply A[0] = 1, Reserved (RESET)
	A[1.0]							1	A_0	comiguiation	rioj i, reserved (ribbbi)
											Note (1) Bit A[0] must be set to 0b after RESET. (2) The setting will be activated after issuing Set Display ON command (AFh)
0	AE	1	0	1	0	1	1	1	0	Set Display OFF	AEh = Display OFF (Sleep mode) (RESET)
0	AF	1	0	1	0	1	1	1	1	Set Display ON	AFh = Display ON
0	В0	1	0	1	1	0	0	0		Set Pre-charge Compensation Enable	A[5:0] = 08h (RESET)
0	A[5:0]	*	*	A ₅	A_4	A_3	A_2	A_1			A[5:0] = 28h, Enable pre-charge compensation
0	B1 A[3:0]	1 *	0	1	1	0 A ₃	0 A ₂	0 A ₁		Set Phase Length	A[3:0] = P1, phase 1 period of 1-15 DCLKs, RESET = 3DCLKS = 3h
0		A_7	A_6	A_5	A_4	*	*	*	*		A[7:4] = P2, phase 2 period of 1-15 DCLKs, RESET = 5DCLKS = 5h
											Note (1) 0 DCLK is invalid in phase 1 & phase 2
0 0	B2 A[7:0]	1 A ₇	0 A ₆	1 A ₅	1 A ₄	0 A ₃	0 A ₂	1 A ₁		(cov mano moquency)	The next command sets the number of DCLKs, K, per row between 2-158 DCLKS RESET = 37DCLKS = 25h The K value should be set as K = P1+P2+GS15 pulse width (RESET: 3+5+29DCLKS)

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Fund	ndamental Command Table										
D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	В3	1	0	1	1	0	0	1	1	Set Display Clock	The lower nibble (A[3:0]) of the next command defines
0	A[3:0]	*	*	*	*	A_3	A_2	A_1	A_0	Divide Ratio /	the divide ratio (D) of display clock (DCLK)
0	A[7:4]	A_7	A_6	A_5	A_4	*	*	*	*	Oscillator Frequency	Divide ratio (D)=A[3:0]+1
	[]	/	0	5	4						(A[3:0]RESET is 0001b, i.e. divide ratio (D) = 2)
											The higher nibble (A[7:4]) of the next command sets the Oscillator Frequency
											Oscillator Frequency increases with the value of A[7:4] and vice versa
											Range: 0000b~1111b
											RESET= 0100b represents 630KHz,
											typical step value: 5% of previous value
	D4	1	0	1	1	0	1	0	0	Set Pre-charge	A[2.0] = 0 (DEGET)
0	В4	1	0	1	1	0	1	0	0	Set Pre-charge	A[2:0] = 0 (RESET)
0	A[2:0]	*	*	*	*	*	A_2	A_1		Compensation Level	A[2:0] = 3h, Recommended level
0	B8	1	0	1	1	1	0	0	0	Set Gray Scale Table	The next eight bytes of command set the gray scale level
0	A[2:0]	*	*	*	*	*	A_2	A_1	A_0		of GS1-15 as below:
0	B[2:0]	*	*	*	*	*	B_2	B_1	B_0		A[2:0] = Gray scale level of GS1, RESET=1
0	B[6:4]	*	B_6	B_5	B_4	*	*	*	*		B[2:0] = Gray scale level of GS2, RESET=1
0	C[2:0]	*	*	*	*	*	C_2	C_1	C_0		B[6:4] = Gray scale level of GS3, RESET=1
0	C[6:4]	*	C_6	C_5	C_4	*	*	*	*		C[2:0] = Gray scale level of GS4 RESET=1
0	D[2:0]	*	*	*	*	*	D_2	D_1	D_0		C[6:4] = Gray scale level of GS5, RESET=1 D[2:0] = Gray scale level of GS6, RESET=1
0	D[6:4]	*	D_6	D_5	D_4	*	*	*	*		D[6:4] = Gray scale level of GS7, RESET=1
0	E[2:0]	*	*	*	*	*	E_2	E_1	E_0		E[2:0] = Gray scale level of GS8, RESET=1
0	E[6:4]	*	E_6	E_5	E_4	*	*	*	*		E[6:4] = Gray scale level of GS9, RESET=1
0	F[2:0]	*	*	*	*	*	F_2	\mathbf{F}_1	F_0		F[2:0] = Gray scale level of GS10, RESET=1
0	F[6:4]	*	F ₆	F_5	F_4	*	*	*	*		F[6:4] = Gray scale level of GS11, RESET=1
0	G[2:0]	*	*	*	*	*	G_2	G_1	G_0		G[2:0] = Gray scale level of GS12, RESET=1
0	G[6:4]	*	G_6	G_5	G_4	*	*	*	*		G[6:4] = Gray scale level of GS13, RESET=1 H[2:0] = Gray scale level of GS14, RESET=1
0	H[2:0]	*	*	*	*	*	H_2	Н	H_0		H[6:4] = Gray scale level of GS15, RESET=1
0	H[6:4]	*	Н	H_5	Н.	*	*	*	*		
0	BC	1	0	115	114	1	1	0	0	Cat Pragharga Valtaga	Second command A[7:0] sets the precharge voltage
0	A[7:0]	1 1	-	1 A 5	-	1	1			Set Frecharge Voltage	level,
0	A[/:0]	Α/	Ab	АЭ	A4	Α3	A2	ΑI	ΑU		$A[7:0]$ 1xxxxxxx connects to V_{COMH}
											$001xxxxx$ $1.0 * V_{REF}$
											00000000 0.51* V _{REF}
											00000001 0.52* V _{REF}
											00011000 0.75* V _{REF} (RESET)
											00011111 0 94* 37
0	BE	1	0	1	1	1	1	1	0	Set V _{COMH} Voltage	
		*	*	_	_		_			Set v _{COMH} voltage	$A[4:0] = 00000 = 0.51*V_{REF}$
0	A[4:0]		"	0	A4	A3	A2	ΑI	ΑU		00001 0.52* V _{REF}
											 10001 0.68* V _{REF} (RESET)
											11101 0.81* V _{REF}
											11110 0.82* V _{REF} 11111 0.84* V _{REF}
			l						l		11111 U.04' V REF

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Fund	Fundamental Command Table										
D/C	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	BF A[3:0]	1 *	0	1 *	1 *	1 A ₃	1 A ₂	1 A ₁		Voltage (VSL)	Second command A[3:0] sets the VSL voltage as follow: A[3:0] = 0010 kept VSL pin NC
											$A[3:0] = 1110$ (RESET) connect a capacitor between VSL pin and V_{SS}
0	E3	1	1	1	0	0	0	1	1	NOP	Command for No Operation

Table 19: Graphic acceleration command

Set (GAC) (D/C# = 0, R/W#(WR#)= 0, E(RD#) = 1) unless specific setting is stated

Graph	Graphic acceleration command										
D/C#	Hex	D7	D6	D5	D4	D3	D2	D2	D 0	Command	Description
0	23 A[4:0]	0	0	1 *	0 A ₄	0 *	0 *	1 A ₁	1 A ₀		A[0] = 0b: Disable Fill rectangle A[0] = 1b: Enable Fill rectangle (RESET)
										Graphic Acceleration Command Options	A[1] = 0b: Disable x-wrap(RESET) A[1] = 1b: Enable wrap around in x-direction during copying and scrolling A[4] = 0b: Disable reverse copy (RESET) A[4] = 1b: Enable reverse during copying.
0	24	0	0	1	0	0	1	0	0		A[5:0]: Column Address of Start
0	A[5:0]	*	*	A_5	A_4	A_3	A_2	A_1	A_0		B[6:0]: Row Address of Start
0	B[6:0]	*	B_6	B_5	B_4	B_3	B_2	B_1	B_0		D[0.0]. Now Muliciss of Start
0	C[5:0]	*	*	C_5	C_4	C_3	C_2	C_1	C_0		C[5:0]: Column Address of End
0	D[6:0]	*	D_6	D_5	D_4	D_3	D_2	D_1	D_0		D[6:0]: Row Address of End
0	E[7:0]	E_7	E_6	E_5	E_4	E_3	E_2	E_1	E ₀		D[0.0]. Row Address of End
										Draw Rectangle	E[7:0]: Set Gray scale pattern E[7:0] This byte is divided into two nibbles. The most significant 4 bits represent the gray scale level of the left pixel of each group. The least significant 4 bits represent the gray scale level of the right pixel of each group. Please refer to Figure 31 for the gray scale pattern setting examples.
											Note: $(1) 0 \le A < C \le 63$ $(2) 0 \le B < D \le 79$
0	25	0	0	1	0	0	1	0	1	Copy	A[5:0]: Column Address of Start
0	A[5:0]	*	*	A_5	A_4	A_3	A_2	\mathbf{A}_1	A_0		B[6:0]: Row Address of Start
0	B[6:0]	*	B_6	B_5	B_4	B_3	B_2	\mathbf{B}_1	B_0		D[0.0]. Now Address of Staft
0	C[5:0]	*	*	C_5	C_4	C_3	C_2	C_1	C_0		C[5:0]: Column Address of End
0	D[6:0]	*	D_6	D_5	D_4	D_3	D_2	\mathbf{D}_1	D_0		DICOLD ALL CELL
0	E[5:0]	*	*	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀		D[6:0]: Row Address of End
0	F[6:0]	**	F_6	F_5	F_4	F_3	F_2	F_1	F_0		

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Graph	Graphic acceleration command										
D /C#	Hex	D7	D6	D5	D4	D3	D2	D2	D0	Command	Description
0 0 0 0	26 A[5:0] B[6:0] C[1:0]	0 * * *	0 * B ₆ *	1 A ₅ B ₅ *	0 A ₄ B ₄ *	0 A ₃ B ₃ *	1 A ₂ B ₂ *	1 A ₁ B ₁ C ₁	$egin{array}{c} 0 \ A_0 \ B_0 \ C_0 \ \end{array}$	Horizontal Scroll	E[5:0]: Column Address of New Start F[6:0]: Row Address of New Start Note:
0	2E	0	0	1	0	1	1	1	0	Stop Moving	This command deactivates the scrolling action. Note (1) After sending 2Eh command to deactivate the scrolling action, the ram data needs to be rewritten.
0	2F	0	0	1	0	1	1	1	1	Start Moving	This command activates the scrolling function according to the setting done by Horizontal Scroll command 26h. Note (1) The "wrap around in x-direction" function must be enabled before scrolling start. i.e. Bit A{1} of command 23h must be set to 1b before issuing 2F command.

Table 20: Read Command Table

(D/C#=0 R/W# (WR#)=1 E (RD#)=1 for 6800 or E (RD#)=0 for 8080)

	(D/C#=0, R/W#(WR#)=1, E(RL	$D_{\#})=1$ for 6800 or E (RD#)=0 for 8080)
		D7 = 0:reserved
		D7 = 1:reserved
		D6 = 0:indicates the display is ON
$D_7D_6D_5D_4D_3D_2D_1$	Status Dogistar Dood	D6 = 1:indicated the display is OFF
D_0	Status Register Read	D5 = 0:reserved
		D5 = 1:reserved
		D4 = 0:reserved
		D4 = 1:reserved

Note
(1) Patterns other than that given in Command Table are prohibited to enter to the chip as a command;
Otherwise, unexpected result will occur

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9.1 Data Read / Write

To read data from the GDDRAM, input HIGH to R/W# (WR#) pin and D/C# pin for 6800-series parallel mode, LOW to E (RD#) pin and HIGH to D/C# pin for 8080-series parallel mode.

In horizontal address increment mode, GDDRAM column address pointer will be increased by one automatically after each data read. In vertical address increment mode, GDDRAM row address pointer will be increased by one automatically after each data read.

Also, a dummy read is required before the first data read. See Figure 5 and Figure 8 in Functional Description.

To write data to the GDDRAM, input LOW to R/W#(WR#) pin and HIGH to D/C# pin for 6800-series parallel mode and 8080-series parallel mode. For serial interface mode, it is always in write mode. In horizontal address increment mode, GDDRAM column address pointer will be increased by one automatically after each data write. In vertical address increment mode, GDDRAM row address pointer will be increased by one automatically after each data write.

It should be noted that, in horizontal address increment mode, the row address pointer would be increased by one automatically if the column address pointer wraps around. In vertical address increment mode, the column address pointer will be increased by one automatically if the row address pointer wraps around.

D/C# **R/W# (WR#) Address Increment Comment** 0 0 Write Command No 0 Read Status 1 No 1 0 Write Data Yes 1 Read Data Yes 1

Table 21: Address Increment Table (Automatic)

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10 COMMAND DESCRIPTIONS

10.1 Fundamental command description

10.1.1 Set Column Address (15h)

This triple byte command specifies column start address and end address of the display data RAM. This command also sets the column address pointer to column start address. This pointer is used to define the current read/write column address in graphic display data RAM. If horizontal address increment mode is enabled by command A0h, after finishing read/write one column data, it is incremented automatically to the next column address. Whenever the column address pointer finishes accessing the end column address, it is reset back to start column address and the row address is incremented to the next row.

10.1.2 Set Row Address (75h)

This triple byte command specifies row start address and end address of the display data RAM. This command also sets the row address pointer to row start address. This pointer is used to define the current read/write row address in graphic display data RAM. If vertical address increment mode is enabled by command A0h, after finishing read/write one row data, it is incremented automatically to the next row address. Whenever the row address pointer finishes accessing the end row address, it is reset back to start row address.

The diagram below shows the way of column and row address pointer movement through the example: column start address is set to 2 and column end address is set to 61, row start address is set to 1 and row end address is set to 78; horizontal address increment mode is enabled by command A0h. In this case, the graphic display data RAM column accessible range is from column 2 to column 61 and from row 1 to row 78 only. In addition, the column address pointer is set to 2 and row address pointer is set to 1. After finishing read/write one pixel of data, the column address is increased automatically by 1 to access the next RAM location for next read/write operation (*solid line in* Figure 18). Whenever the column address pointer finishes accessing the end column 61, it is reset back to column 2 and row address is automatically increased by 1 (*solid line in* Figure 18). While the end row 78 and end column 61 RAM location is accessed, the row address is reset back to 1 and the column address is reset back to 2 (*dotted line in* Figure 18).

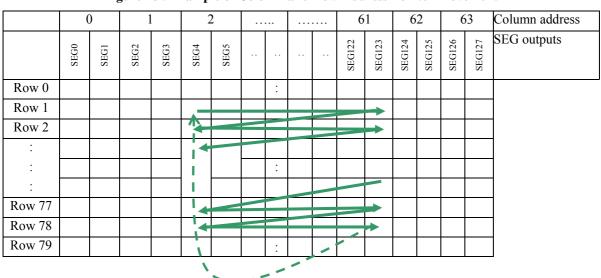


Figure 18: Example of Column and Row Address Pointer Movement

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10.1.3 Set Contrast Current (81h)

This command is to set Contrast Setting of the display. The chip has 128 contrast steps from 00H to 7FH. The segment output current increases with the increase of contrast step. See Figure 19 below.

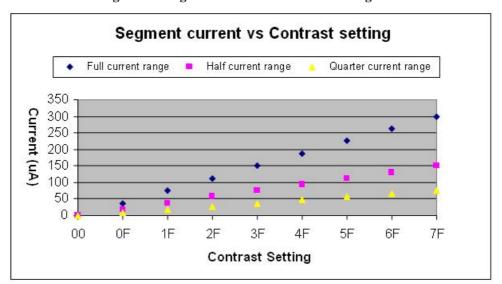


Figure 19: Segment current vs Contrast setting

10.1.4 Set Current Range (84h, 85h, 87h)

This command is used to select quarter range or half range or full range current mode. With the same contrast level, quarter range mode will give a quarter of the current output of the full range mode. Similar to half range current mode, it will give a half of the current output of the full range mode. See Figure 19. In RESET, quarter range current mode is default.

10.1.5 Set Re-map (A0h)

This double command has multiple configurations and each bit setting is described as follows:

- Column Address Remapping (A[0])
 This bit is made for increase the flexibility layout of segment signals in OLED module with segment arranged from left to right (when A[0] is set to 0) or from right to left (when A[0] is set to 1).
- Nibble Remapping (A[1])
 When A[1] is set to 1, the two nibbles of the data bus for RAM access are re-mapped, such that (D7, D6, D5, D4, D3, D2, D1, D0) acts like (D3, D2, D1, D0, D7, D6, D5, D4).
 If this feature works together with Column Address Re-map, it would produce an effect of flipping the outputs from SEG0~127 to SEG127~SEG0 as show in Table 13.
- Address increment mode (A[2])
 When A[2] is set to 0, the driver is set as horizontal address increment mode. After the display
 RAM is read / written, the column address pointer is increased automatically by 1. If the column
 address pointer reaches column end address, the column address pointer is reset to column start
 address and row address pointer is increased by 1. The sequence of movement of the row and
 column address point for horizontal address increment mode is shown in Figure 20

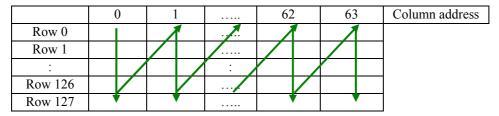
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Figure 20: Address Pointer Movement of Horizontal Address Increment Mode

	0	1		62	63	Column address
Row 0					†	
Row 1	-				1	
:	4.	:	:	·	 :	
Row 78	-				†	
Row 79	+				<u></u>	

When A[2] is set to 1, the driver is set to vertical address increment mode. After the display RAM is read / written, the row address pointer is increased automatically by 1. If the row address pointer reaches the row end address, the row address pointer is reset to row start address and column address pointer is increased by 1. The sequence of movement of the row and column address point for vertical address increment mode is shown in Figure 21.

Figure 21: Address Pointer Movement of Vertical Address Increment Mode



• COM Remapping (A[4])

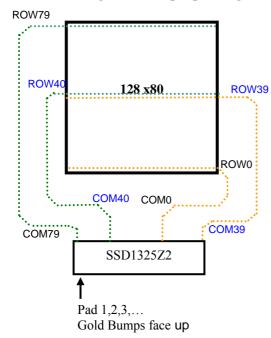
This bit defines the scanning direction of the common for flexible layout of common signals in OLED module either from up to down (when A[4] is set to 0) or from bottom to up (when A[4] is set to 1). Table 14 shows an example of the using the COM Remapping to perform vertical scrolling.

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Splitting of Odd / Even COM Signals (A[6])
 This bit is made to match the COM layout connection on the panel.

When A[6] is set to 0, no splitting odd / even of the COM signal is performed, output pin assignment sequence is shown as below (for 80MUX ratio):

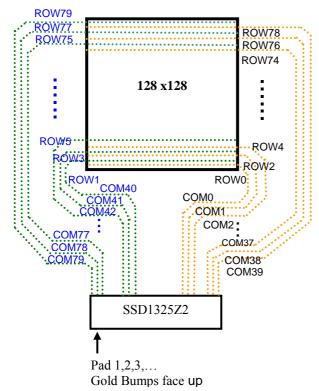
Figure 22: Output pin assignment when command A0h bit A[6]=0.



Output Pin Connection				
SSD1325Z2	Panel			
COM0	ROW0			
COM1	ROW1			
COM2	ROW2			
COM3	ROW3			
• •	• •			
COM39	ROW39			
COM40	ROW40			
:	:			
COM77	ROW77			
COM78	ROW78			
COM79	ROW79			

When A[6] is set to 1, splitting odd / even of the COM signal is performed, output pin assignment sequence is shown as below (for 128MUX ratio):

Figure 23: Output pin assignment when command A0h bit A[6]=1.



Output Pin Connection				
SSD1325Z2	Panel			
COM0	ROW0 (Even)			
COM1	ROW2			
COM2	ROW4			
:	:			
COM37	ROW74			
COM38	ROW76			
COM39	ROW78			
COM40	ROW1 (Odd)			
COM41	ROW3			
COM42	ROW5			
:	:			
COM77	ROW75			
COM78	ROW77			
COM79	ROW79			

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10.1.6 Set Display Start Line (A1h)

This double byte command is to set Display Start Line register for determining the starting address of display RAM to be displayed by selecting a value from 0 to 79. Figure 24 shows an example using this command of this command when MUX ratio= 80 and MUX ratio= 54 and Display Start Line = 28. In there, "ROW" means the graphic display data RAM row.

Figure 24: Example of Set Display Start Line with no Remapping

	MUX ratio (A8h) = 80	MUX ratio (A8h) = 80		MUX ratio $(A8h) = 54$
COM Pir	Display Start Line (A1h)			
	= 0	= 28	=0	= 28
COM0	ROW0	ROW28	ROW0	ROW28
COM1	ROW1	ROW29	ROW1	ROW29
COM2	ROW2	ROW30	ROW2	ROW30
COM3	ROW3	ROW31	ROW3	ROW31
:		:	:	:
:		:	:	:
COM23	ROW23	ROW51	ROW23	ROW51
COM24	ROW24	ROW52	ROW24	ROW52
COM25	ROW25	ROW53	ROW25	ROW53
COM26	ROW26	ROW54	ROW26	ROW54
:	•	:	:	:
	-	:	:	:
COM49	ROW50	ROW77	ROW50	ROW77
COM51	ROW51	ROW78	ROW51	ROW78
COM52	ROW52	ROW79	ROW52	ROW79
COM53	ROW53	ROW0	ROW53	ROW0
COM54	ROW54	ROW1	-	-
COM55	ROW55	ROW2	-	-
:		:	:	:
:	-	:	:	:
COM76	ROW76	ROW24	-	-
COM77	ROW77	ROW25	-	-
COM78	ROW78	ROW26	-	-
COM79	ROW79	ROW27	-	-
Display				
Example		SOLOMON		SOLOMON
		SYSTECH		SYSTECH
	SOLOMON	STSTEUM	COLONION	3131501
	SYSTECH			

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10.1.7 Set Display Offset (A2h)

This double byte command specifies the mapping of display start line (it is assumed that COM0 is the display start line, display start line register equals to 0) to one of COM0~COM79. Figure 25 shows an example using this command when MUX ratio= 80 and MUX ratio= 54 and Display Offset = 28. In there, "Row" means the graphic display data RAM row.

Figure 25: Example of Set Display Offset with no Remapping

	MUX ratio (A8h) = 80	MUX ratio (A8h) = 80	MUX ratio $(A8h) = 64$	MUX ratio (A8h) = 64
COM Pir	Display Offset (A2h)=0	Display Offset (A2h)=18	Display Offset (A2h)=0	Display Offset (A2h)=18
COM0	ROW0	ROW28	ROW0	ROW28
COM1	ROW1	ROW29	ROW1	ROW29
COM2	ROW2	ROW30	ROW2	ROW30
COM3	ROW3	ROW31	ROW3	ROW31
:	:	•	:	:
:	:	•	:	:
COM23	ROW23	ROW51	ROW23	ROW51
COM24	ROW24	ROW52	ROW24	ROW52
COM25	ROW25	ROW53	ROW25	ROW53
COM26	ROW26	ROW54	ROW26	-
:	:	•	:	:
:	:	•	:	:
COM49	ROW50	ROW77	ROW50	-
COM51	ROW51	ROW78	ROW51	-
COM52	ROW52	ROW79	ROW52	-
COM53	ROW53	ROW0	ROW53	ROW0
COM54	ROW54	ROW1	-	ROW1
COM55	ROW55	ROW2	-	ROW2
:	:	-	:	:
:	:	-	:	:
COM76	ROW76	ROW24	-	ROW24
COM77	ROW77	ROW25	-	ROW25
COM78	ROW78	ROW26	-	ROW26
COM79	ROW79	ROW27	-	ROW27
Display Example	SOLOMON	SOLOMON		COLOMON

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10.1.8 Set Display Mode (A4h ~ A7h)

These are single byte commands (A4h \sim A7h) and are used to set display status to Normal Display, Entire Display ON, Entire Display OFF or Inverse Display, respectively.

• Normal Display (A4h)
Reset the "Entire Display ON, Entire Display OFF or Inverse Display" effects and turn the data to ON at the corresponding gray level. Figure 26 shows an example of Normal Display.

Figure 26: Example of Normal Display





Memory

Set Entire Display ON (A5h)

Force the entire display to be at gray scale level GS15, regardless of the contents of the display data RAM, as shown on Figure 27.

Figure 27: Example of Entire Display ON





Memory

Display

Set Entire Display OFF (A6h)
 Force the entire display to be at gray scale level GS0, regardless of the contents of the display data RAM, as shown on Figure 28.

Figure 28: Example of Entire Display OFF





Display

• Inverse Display (A7h)
The gray scale level of display data are swapped such that "GS0" <-> "GS15", "GS1" <-> "GS14", etc. Figure 29 shows an example of inverse display.

Figure 29: Example of Inverse Display





Display

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10.1.9 Set Multiplex Ratio (A8h)

This double byte command sets multiplex ratio (MUX ratio) from 16MUX to 80MUX. In RESET, multiplex ratio is 80MUX. Please refer to Figure 24 and Figure 25 for the example of setting different MUX ratio.

10.1.10 Set Master Configuration (ADh)

This command selects the external V_{CC} power supply. External V_{CC} power should be connected to the V_{CC} pin. A[0] bit must be set to 0b after RESET.

This command will be activated after issuing Set Display ON command (AFh)

10.1.11 Set Display ON/OFF (AEh / AFh)

These single byte commands are used to turn the matrix display on the OLED panel display either ON or OFF. For AEh, the display is OFF, the segment and common output are in high impedance state and circuits will be turned OFF. When the sleep mode is set to OFF (AFh), the display is ON.

10.1.12 Set V_{COMH} Voltage (BEh)

This double byte command sets the high voltage level of common pins, V_{COMH} . The level of V_{COMH} is programmed with reference to V_{CC} . Please refer to Table 18 for detail information and breakdown levels of each step.

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10.1.13 Set Precharge Voltage (BCh)

This double byte command is used to set the pre-charge voltage (phase 2) level. Please refer to Table 18 for detail information and breakdown levels of each step.

10.1.14 Set Phase Length (B1h)

This is a double byte command. In the second byte of this double command, lower nibble and higher nibble is defined separately. The lower nibble adjusts the phase length of Reset (phase 1). The higher nibble is used to select the phase length of the pre-charge phase (phase 2). The phase length is ranged from 1 to 16 DCLK's. RESET for A[3:0] is set to 3h while reset for A[7:4] is set to 5h. Please refer to Table 18 for detail breakdown levels of each step.

10.1.15 Set Row Period (B2h)

This command is used to set the row period. It is defined by multiplying the internal display clock period by the number of internal display clocks per row (valued from 14h to 7Fh), and RESET is 25h. The larger the value, the more precise of each gray scale level can be tuned. See "Gray Scale Table" command (B8h) for details. Also, it is used to define the frame frequency altogether with the use of "Display Clock Divide Ratio" command (B3h). Row period equals to the sum of phase 1 and phase 2 periods and the pulse width of GS15. See equation in Table 18.

10.1.16 Set Display Clock Divide Ratio (B3h)

This double command is used to set the frequency of the internal display clocks, DCLK's. It is defined by dividing the oscillator frequency by the divide ratio (valued from 1 to 16). Frame frequency is determined by divide ratio, number of display clocks per row, MUX ratio and oscillator frequency. The lower nibble of the second byte is used to select the oscillator frequency. Please refer to Table 18 for detail breakdown levels of each step.

10.1.17 Set Gray Scale Table

This command is used to set each individual gray scale level for the display. Except gray scale level GS0 that has no pre-charge and current drive, the pulse width of each gray scale level is programmed with unit of DCLK. The longer the length of the pulse width, the brighter the OLED pixel when it is turned ON.

The setting of gray scale table entry can perform gamma correction on OLED panel display. Normally, it is desired that the brightness response of the panel is linearly proportional to the image data value in display data RAM. However, the OLED panel is somehow responded in non-linear way. Appropriate gray scale table setting like example below can compensate this effect.

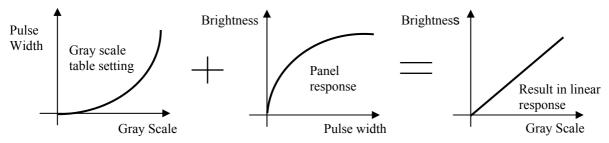


Figure 30: Example of gamma correction by gray scale table setting

As shown in Table16 and

Table 17, GS1 is defined with pulse width equals to the first offset value, L1, select from 0-7 internal display clocks. GS2 is defined with pulse width equals to GS1 plus the next offset value, L2, select from 1-8 internal display clocks. Similarly, the next GS level is defined with pulse width equals to its lower one GS level plus the next offset value, select from 1-8 internal display clocks. In normal operation, GS15 should take the full current drive period as its pulse width. Therefore, the row period should be set as the

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sum of phase 1 period, phase 2 periods, and the pulse width of GS15 with the use of "Row period" command.

10.1.18 NOP (E3h)

This is a no operation command.

10.1.19 Status register Read

This command is issued by setting D/C# LOW during a data read (refer to Figure 34 to Figure 36 parallel interface waveform). It allows the MCU to monitor the internal status of the chip.

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10.2 Graphic Acceleration Command Set Description

10.2.1 Graphic Acceleration Command Options (23h)

This command has two functions.

- Enable / Disable fill (A[0])
 - 0 = Disable filling of rectangle in draw rectangle command.
 - 1 = Enable filling of rectangle in draw rectangle command. (RESET)
- Enable / Disable x-warp (A[1])
 - 0 = Disable wrap around in x-direction during copying and scrolling
 - 1 = Enable wrap around in x-direction during copying and scrolling (RESET)
- Enable / Disable reverse copy (A[4])
 - 0 = Disable reverse copy (RESET)
 - 1 = During copy command, the new image colors are swapped such that "GS0" <-> "GS15", "GS1" <-> "GS14",

10.2.2 Draw Rectangle (24h)

Specify a starting point (Row 1, Column 1) and an ending point (Row 2, Column 2) as well as giving the desire gray scale pattern, a rectangle will then be drawn.

Row 1,
Column 1

Gray scale pattern
=A0h

Row 2,
Column 2

Row 2,
Column 2

Figure 31: Example of draw rectangle command

The following example illustrates the rectangle drawing command sequence.

- 1. Enter the "draw rectangle mode" by execute the command 24h
- 2. Set the starting column coordinates, Column 1. e.g., 01h.
- 3. Set the starting row coordinates, Row 1. e.g., 01h.
- 4. Set the finishing column coordinates, Column 9. e.g., 09h
- 5. Set the finishing row coordinates, Row 5. e.g., 05h
- 6. Set the gray scale pattern:

This byte is divided into two nibbles. The most significant 4 bits represent the gray scale level of the left pixel of each group. The least significant 4 bits represent the gray scale level of the right pixel of each group. Please refer to Figure 31 for the gray scale pattern setting examples.

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10.2.3 Copy (25h)

Copy the rectangular region defined by the starting point (Row 1, Column 1) and the ending point (Row 2, Column 2) to location (Row 3, Column 3). If the new coordinates are smaller than the ending points, the new image will overlap the original one.

The following example illustrates the copy procedure.

- 1. Enter the "copy mode" by execute the command 25h
- 2. Set the starting column coordinates, Column 1. E.g., 00h.
- 3. Set the starting row coordinates, Row 1. E.g., 00h.
- 4. Set the finishing column coordinates, Column 2. E.g., 05h
- 5. Set the finishing row coordinates, Row 2. E.g., 05h
- 6. Set the new column coordinates, Column 3. E.g., 03h
- 7. Set the new row coordinates, Row 3. E.g., 03h

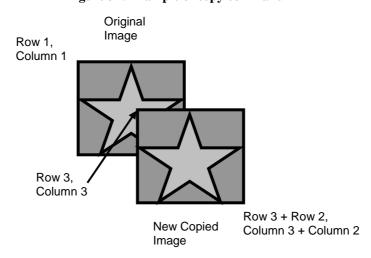


Figure 32: Example of copy command

10.2.4 Horizontal Scroll (26h)

This command consists of 3 consecutive bytes to set up the scrolling parameters. It determined the horizontal scrolling offset, no of scrolling row and scrolling speed. Some scrolling examples are shown in Figure 33.

Before issuing this command, the scrolling must be deactivated (2Eh). Otherwise, RAM content may be corrupted.

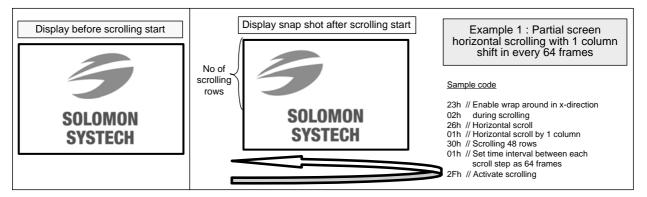


Figure 33: Scrolling examples

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10.2.5 Stop Moving (2Eh)

Stop motion of scrolling. After sending 2Eh command to deactivate the scrolling action, the ram data needs to be rewritten.

10.2.6 Start Moving (2Fh)

Start motion of scrolling. This command should only be issued after scrolling setup parameters are defined through command 26h and the function of wrap around in x-direction is enabled through 23h.

The following actions are prohibited after the horizontal scroll is activated

- 1. RAM access (Data write or read)
- 2. Changing scrolling setup parameters

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11 MAXIMUM RATINGS

Table 22 : Maximum Ratings (Voltage Reference to V_{SS})

Symbol	Parameter	Value	Unit
$ m V_{DD}$		-0.3 to +4.0	V
V_{CC}	Supply Voltage	0 to +17.0	V
$ m V_{REF}$		0 to +17.0	V
$ m V_{SEG}$	SEG output voltage	$0 \text{ to } +V_{CC}$	V
V_{COM}	COM output voltage	0 to $+0.9$ x V_{CC}	
$ m V_{in}$	Input voltage	V_{SS} -0.3 to V_{DD} +0.3	V
$T_{\mathbf{A}}$	Operating Temperature	-40 to +85	°C
$\mathrm{T_{stg}}$	Storage Temperature Range	-65 to +150	°C

Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description.

This device may be light sensitive. Caution should be taken to avoid exposure of this device to any light source during normal operation. This device is not radiation protected.

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12 DC CHARACTERISTICS

Conditions (unless specified):

Voltage referenced to V_{SS};

 V_{DD} = 2.7, V_{CC} = 12.0V, I_{REF} = 10uA, at T_A = 25°C.

Table 23: DC Characteristics

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V_{CC}	Operating Voltage	-	8.0	12.0	16.0	V
$V_{ m DD}$	Logic Supply Voltage	-	2.4	2.7	3.5	V
V_{OH}	HIGH Logic Output Level	$I_{OUT} = 100uA, 3.3MHz$	$0.9*V_{DD}$	-	V_{DD}	V
V_{OL}	LOW Logic Output Level	$I_{OUT} = 100uA, 3.3MHz$	0	-	$0.1*V_{DD}$	V
$ m V_{IH}$	HIGH Logic Input Level	-	$0.8*V_{\mathrm{DD}}$	1	$V_{ m DD}$	V
$ m V_{IL}$	LOW Logic Input Level	-	0	1	$0.2*V_{DD}$	V
I_{SLEEP}	Sleep mode Current	No loading	ı	0.2	5	uA
I_{CC}	$V_{CC} \ Supply \ Current$ V_{DD} =2.7V, external V_{CC} =12V, I_{REF} =10uA, Frame rate=110Hz, All one pattern, Display ON, no loading	Contrast = 7F	-	700	-	uA
${ m I_{DD}}$	$V_{DD} \ Supply \ Current$ $V_{DD} = 2.7V, \ external \ V_{CC} = 12V, \ I_{REF} = 10uA, \ Frame \\ rate = 110Hz, \ All \ one \ pattern, \ Display \ ON, \ no \ loading$	Contrast = 7F	-	-	650	uA
	Segment Output Current	Contrast = 7F	270	300	370	
,		Contrast = 5F	-	225	-	
I_{SEG}	V_{DD} =2.7V, V_{CC} =12V, I_{REF} =10uA, Frame rate=110Hz, Display ON, Segment pin under test is	Contrast = 3F	-	150	-	uA
	connected with a 20K resistive load to V_{SS}	Contrast = 1F	-	75	-	
Dev	Segment output current uniformity	Adjacent pin	-1.5	-	+1.5	%
	V_{DD} =2.7V, V_{CC} =12V, I_{REF} =10uA, Contrast=7F	Overall pin to pin	-3	-	+3	, 0

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13 AC CHARACTERISTICS

Conditions (Unless otherwise specified):

Voltage referenced to $V_{\rm SS}$ $V_{DD} = 2.4V \text{ to } 3.5V$ $V_{CC} = 8.0V \text{ to } 16.0V$ $T_A = 25$ °C

Table 24 : AC Characteristics

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
F _{OSC}	Oscillation Frequency of Display Timing Generator	$V_{DD} = 2.7V$	535	630	725	kHz
F_{FRM}	Frame Frequency for 128 MUX Mode	128x80 Graphic Display Mode, Display ON, Internal Oscillator Enabled	-	F _{OSC} * 1/(D*K*80)	-	Hz
	Reset LOW pulse width	-	3	-	-	us
RES#	Reset complete time	-	-	-	2	us

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Note:(1) Fose stands for the frequency value of the internal oscillator and the value is measured when command B3h A[7:4]

⁽²⁾ D stands for divide ratio

 $^{^{(3)}}$ K stands for total number of display clocks per row defined by command B2h $^{(4)}$ N stands for number of MUX selected by command A8h

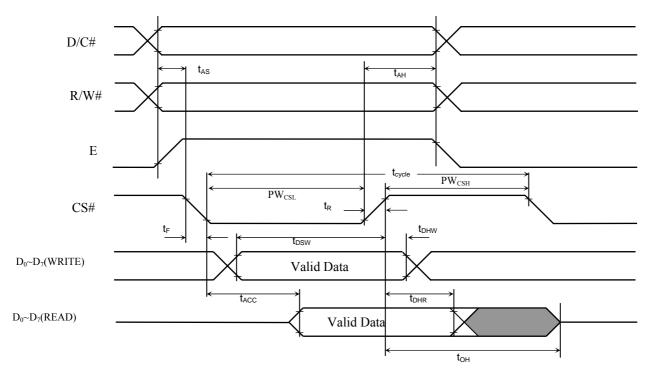
Conditions:

 V_{DD} - V_{SS} = 2.4 to 3.5V T_A = 25°C

Table 25: 6800-Series MCU Parallel Interface Timing Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
t _{cvcle}	Clock Cycle Time	300	-	-	ns
t _{AS}	Address Setup Time	0	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
$t_{ m DHW}$	Write Data Hold Time	15	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t _{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (read)	120	-	-	ns
	Chip Select Low Pulse Width (write)	60			
PW_{CSH}	Chip Select High Pulse Width (read)	60	-	-	ns
	Chip Select High Pulse Width (write)	60			
t_R	Rise Time	-	-	15	ns
$t_{\rm F}$	Fall Time	-	-	15	ns

Figure 34: 6800-series MCU Parallel Interface Characteristics



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Conditions:

 V_{DD} - V_{SS} = 2.4 to 3.5V T_A = 25°C

Table 26: 8080-Series MCU Parallel Interface Timing Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	300	-		ns
t_{AS}	Address Setup Time	10	-	1	ns
t_{AH}	Address Hold Time	0	-	-	ns
$t_{ m DSW}$	Write Data Setup Time	40	-	-	ns
$t_{ m DHW}$	Write Data Hold Time	15	-	•	ns
$t_{ m DHR}$	Read Data Hold Time	20	-	•	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
t_{PWLR}	Read Low Time	120	-	1	ns
t_{PWLW}	Write Low Time	60	-	-	ns
t_{PWHR}	Read High Time	60	-	-	ns
t_{PWHW}	Write High Time	60	-	-	ns
t_{R}	Rise Time	-	-	15	ns
$t_{\rm F}$	Fall Time	-	-	15	ns
t_{CS}	Chip select setup time	0	-	-	ns
t_{CSH}	Chip select hold time to read signal	0	-	ı	ns
t_{CSF}	Chip select hold time	20	-	-	ns

Figure 35: 8080-series parallel interface characteristics (Form 1)

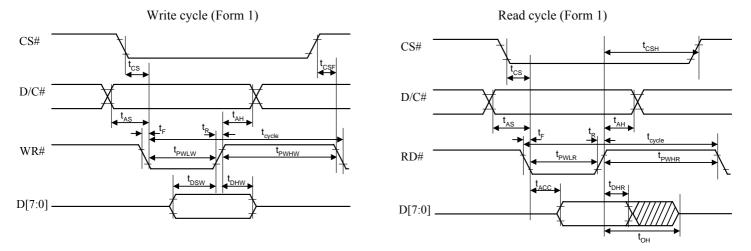
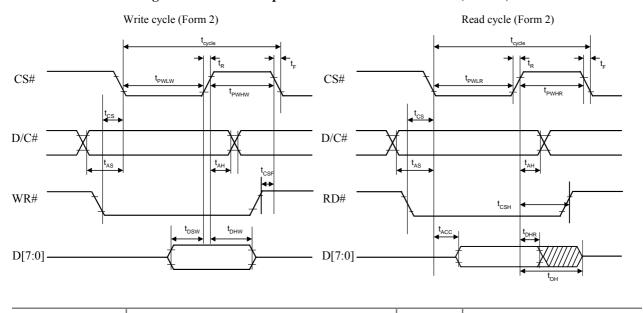


Figure 36: 8080-series parallel interface characteristics (Form 2)



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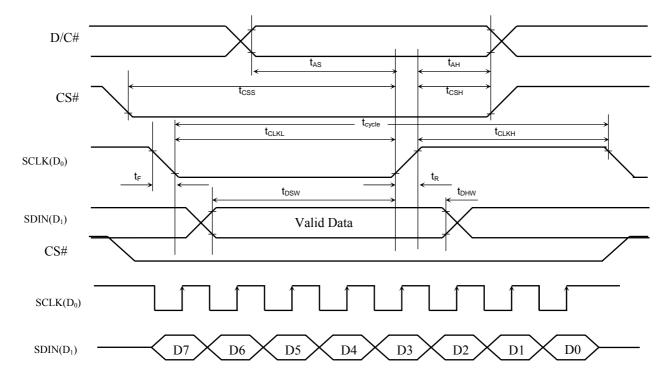
Conditions:

 V_{DD} - V_{SS} = 2.4 to 3.5V T_A = 25°C

Table 27 : Serial Interface Timing Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	250	-	-	ns
t_{AS}	Address Setup Time	150	-	-	ns
t_{AH}	Address Hold Time	150	-	-	ns
t_{CSS}	Chip Select Setup Time	120	-	-	ns
t_{CSH}	Chip Select Hold Time	60	-	-	ns
t_{DSW}	Write Data Setup Time	100	-	-	ns
t_{DHW}	Write Data Hold Time	100	-	-	ns
t_{CLKL}	Clock Low Time	100	-	-	ns
t_{CLKH}	Clock High Time	100	-	-	ns
t_R	Rise Time	-	-	15	ns
$t_{\rm F}$	Fall Time	-	-	15	ns

Figure 37 : Serial Interface Characteristics



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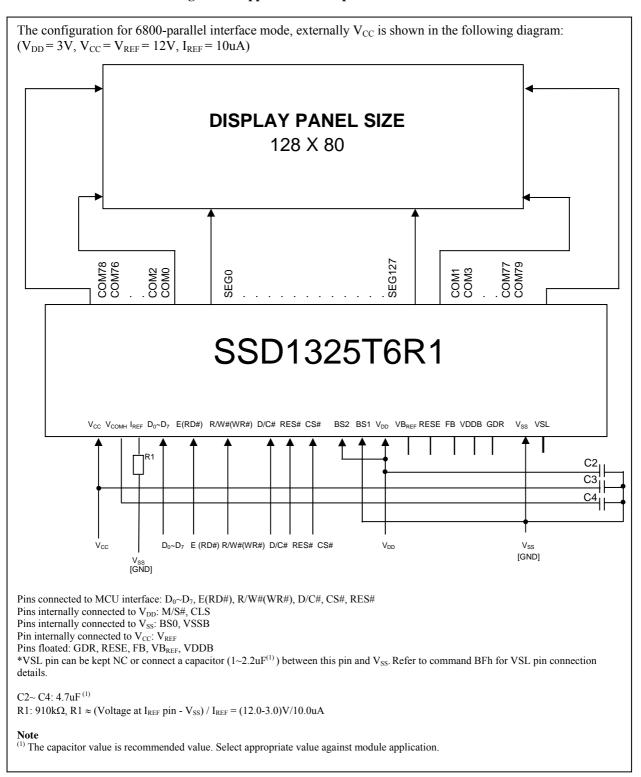
14 APPLICATION EXAMPLES

The configuration for SPI serial interface mode, externally V_{CC} is shown in the following diagram: $(V_{DD} = 3V, V_{CC} = V_{REF} = 12V, I_{REF} = 10uA)$ **DISPLAY PANEL SIZE** 128 X 80 SEG127 SSD1325Z2 E(RD#) R/W#(WR#) D/C# RES# CS# V_{SS} V_{CC} V_{COMH} V_{DD} C1 C2 С3 D/C# RES# CS# D₀ (SCLK) D₁ (SDIN) V_{SS} (GND) V_{CC} Pins connected to MCU interface: D₀, D₁, D/C#, RES#, CS# Pins internally connected to V_{DD} : M/S#, CLS, VDDB Pins internally connected to V_{SS} : BS0, BS1, BS2, E(RD#), R/W#(WR#), VSSB, VCL Pin internally connected to V_{CC}: V_{REF} Pins floated: CL, GDR, RESE, FB, VB_{REF} *VSL pin can be kept NC or connect a capacitor (1~2.2uF⁽¹⁾) between this pin and V_{SS}. Refer to command BFh for VSL pin connection C1: 1uF, C2~ C3: 4.7uF $^{(1)}$ R1: 910kΩ, R1 ≈ (Voltage at I_{REF} pin - V_{SS}) / I_{REF} = (12.0-3.0)V/10.0uA **NOTE**(1) The capacitor value is recommended value. Select appropriate value against module application.

Figure 38: Application Example for SSD1325Z2 SPI serial interface mode

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Figure 39: Application Example for SSD1325T6R1

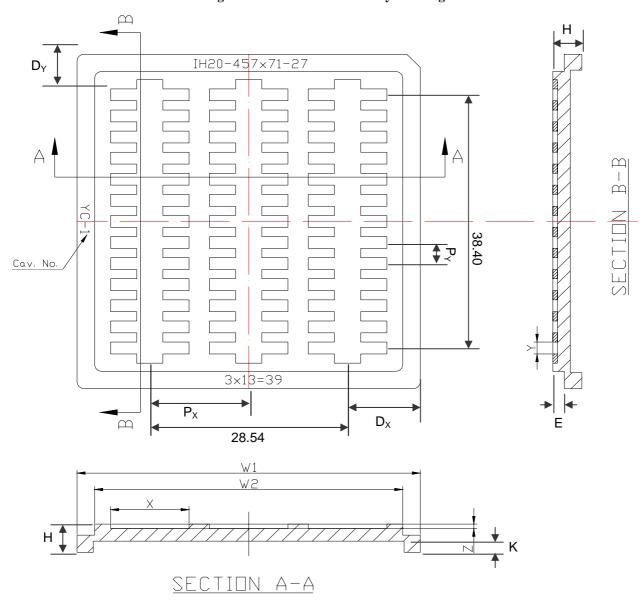


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15 PACKAGE INFORMATION

15.1 SSD1325Z2 Die Tray Information

Figure 40: SSD1325Z2 Die Tray Drawing



Remark

1. Depth of text: Max. 0.1mm

2. Tray material: ABS3. Tray color code: Black

4. Surface resistance $10^9 \sim 10^{11} \Omega$

5. Tray warpage: Max 0.10mm

6. Unspecifier dim's tolerance: ± 0.15mm

7. Pocket size: 13.56 x 1.65 x 0.61mm

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Table 28: SSD1325Z2 Die Tray Dimensions

Parameter	Dimensions
Farameter	mm (mil)
W1	50.70±0.2 (1996)
W2	45.50±0.2 (1791)
Н	4.05±0.2 (160)
E	1.75±0.2 (69)
K	1.45±0.2 (57)
P_{X}	14.27±0.1 (562)
P_{Y}	3.20±0.1 (126)
X	11.60±0.1 (457)
Y	1.80±0.1 (71)
Z	0.68±0.05 (27)
D_X	11.08±0.1 (437)
D_{Y}	6.15±0.1 (242)
N (number of die)	39

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15.2 SSD1325T6R1 Detail Dimension

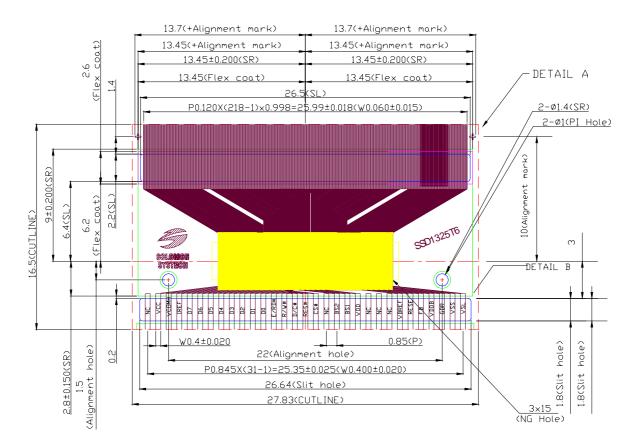


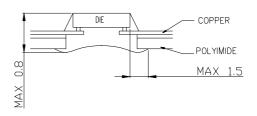
Figure 41: SSD1325T6R1 Detail Dimension

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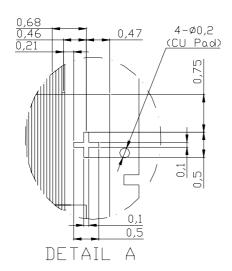
NOTE:

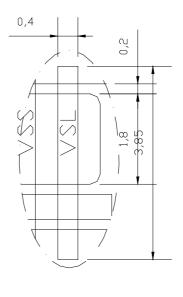
- 1. GENERAL TOLERANCE: ±0.05mm 2. CUTLINE TOLERANCE: ±0.15mm 3. MATERIAL
- - PI: 75±6um CU: 18±5um

 - SR: 26±14um
 - ADHESIVE: 12±2um
- 4. FLEX COATING: Min10um 5. SN PLATING: 0.20±0.05um
- 6. TAPSITE: 4 SPH, 19.00mm



MIRROR DESIGN





DETAIL B

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